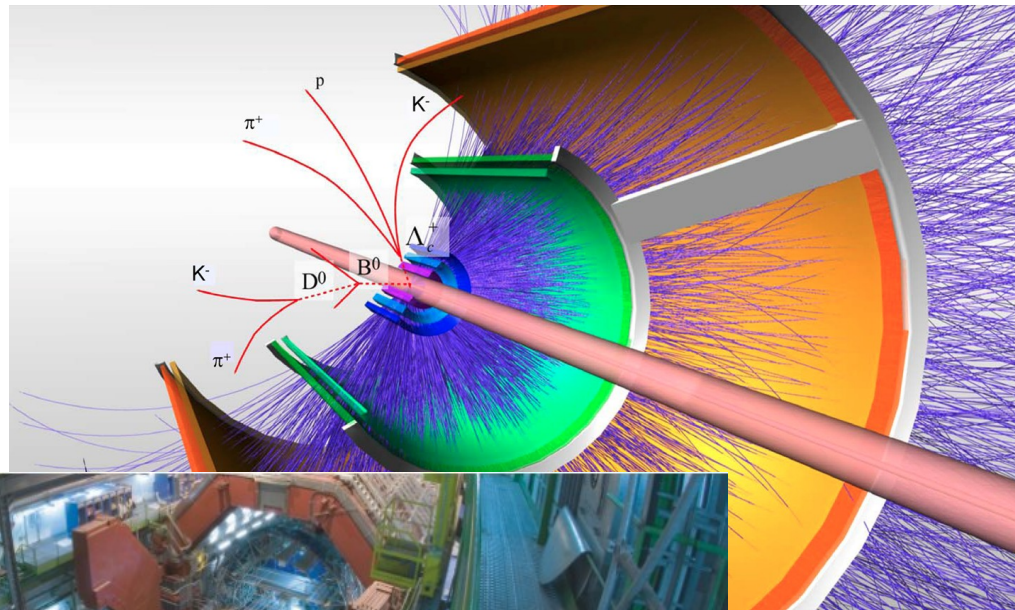


Towards a QCD+QGP physics at HL-LHC with ultra-low p_T detection :

ALICE ITS-3 + “all-Si experiment”



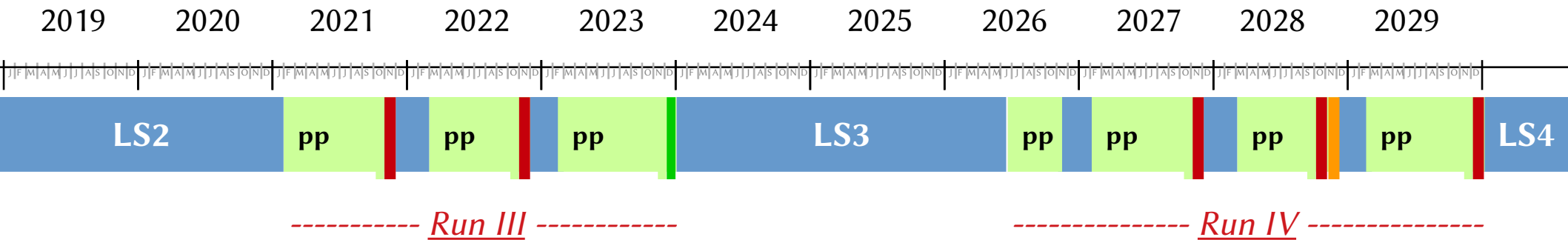
Foreword : brainstorming in progress...

FIELD	CONTACTS	Th/Exp	1 st approach	Discussion
hydrodynamics	Jean-Yves Ollitrault	Th	√	√
hydrodynamics	Stefan Flörchinger	Th	√	√
hydrodynamics	Aleksas Mazeliauskas	Th	√	√
CNM	François Arléo	Th	√	√
CNM	Stéphane Peigné	Th	√	√
CGC	François Gellis	Th	√	TbD
jets	Grégory Soyez	Th	√	TbD
EFT	Jacopo Ghiglieri	Th	√	TbD
fluctuations	Derek Teaney	Th	√	TbD
fluctuations	Marlene Nahrgang	Th	TbD	...
net quantum numbers	Alice Ohlson	Exp	√	√
charm	Pol-Bernard Gossiaux	Th	√	√
ALICE TOF + light nuclei	Francesca Bellini	Exp	√	...
CMS MTD	Andre Stahl, Wei Li	Exp	√	√
e ⁺ p, ATLAS, CMS, H1	E. Sauvan, C. Diaconu, E. Perez, L. Schoeffel	Exp	√	√/...
BSM in HI	David d'Enterria	Exp	TbD	TbD
...	+You ?

Looking for contradictors
+ different perspectives...

√ = New since *GdR QCD 25/11/19*

Outline



- A. Physics cases at HL-LHC (*runs IV + V*)
- B. ≥ 2026 , Run 4 (*ALICE ITS3*)
- C. ≥ 2031 , Run 5 (*All-Si experiment*)

Part A – some physics cases

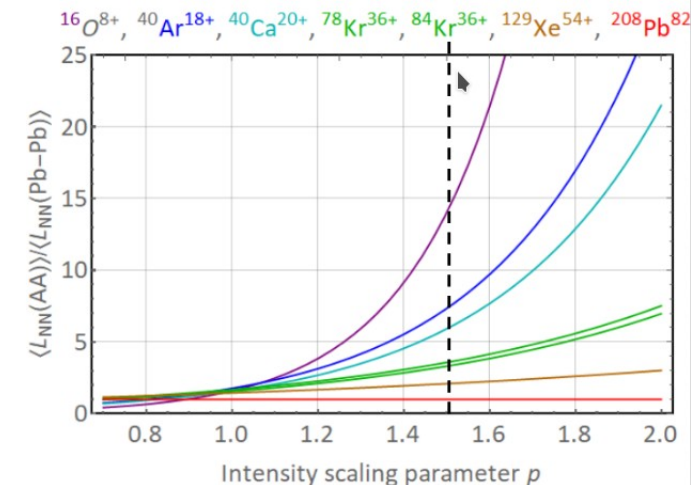
I.0 – HL-LHC QCD+QGP : AA beyond 2029 ?

0. First things first : as of 2019 = no plan of “AA” runs after HL-LHC run 4

1. If AA in Run >V, likely not to be $^{208}\text{Pb}^{82+} - ^{208}\text{Pb}^{82+}$ but something of lower A
i.e. trade off to be found between (increased instantaneous luminosity) Vs. (QGP effects)

	$^{16}\text{O}^{8+}$	$^{40}\text{Ar}^{18+}$	$^{40}\text{Ca}^{20+}$	$^{78}\text{Kr}^{36+}$	$^{129}\text{Xe}^{54+}$	$^{208}\text{Pb}^{82+}$
γ	3760.	3390.	3760.	3470.	3150.	2960.
$\sqrt{s_{\text{NN}}}/\text{TeV}$	7.	6.3	7.	6.46	5.86	5.52
σ_{had}/b	1.41	2.6	2.6	4.06	5.67	7.8
σ_{BFPP}/b	2.36×10^{-5}	0.00688	0.0144	0.88	15.	280.
σ_{EMD}/b	0.0738	1.24	1.57	12.2	51.8	220.
σ_{tot}/b	1.48	3.85	4.18	17.1	72.5	508.
N_b	6.24×10^9	1.85×10^9	1.58×10^9	6.53×10^8	3.56×10^8	1.9×10^8
$\epsilon_{\text{xn}}/\mu\text{m}$	2.	1.8	2.	1.85	1.67	1.58
$f_{\text{IBS}}/(\text{m Hz})$	0.0662	0.0894	0.105	0.13	0.144	0.167
W_b/MJ	68.9	45.9	43.6	32.5	26.5	21.5
$L_{\text{AA0}}/\text{cm}^{-2}\text{s}^{-1}$	1.46×10^{31}	1.29×10^{30}	9.38×10^{29}	1.61×10^{29}	4.76×10^{28}	1.36×10^{28}
$L_{\text{NN0}}/\text{cm}^{-2}\text{s}^{-1}$	3.75×10^{33}	2.06×10^{33}	1.5×10^{33}	9.79×10^{32}	7.93×10^{32}	5.88×10^{32}
...

• Table 4, Ch.2 WG5 Yellow Report
[arXiv:1812.06772](https://arxiv.org/abs/1812.06772)



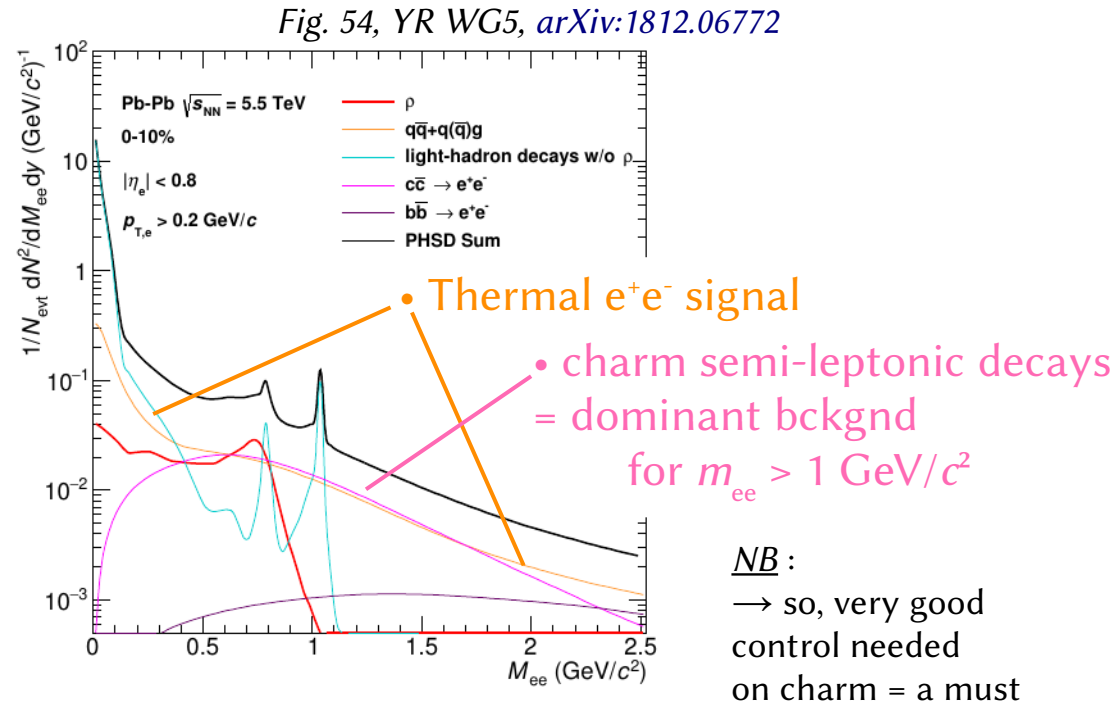
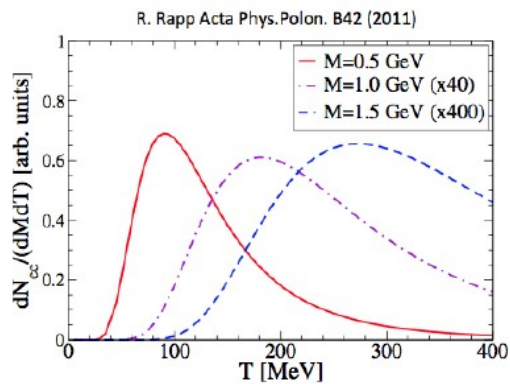
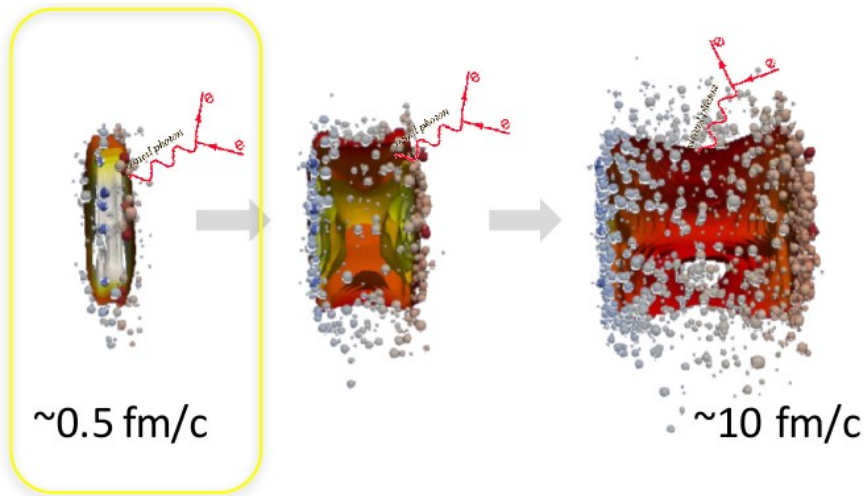
• WG5 Yellow Report, general meeting, 30/10/2018, [Indico.cern.ch/758181](https://indico.cern.ch/758181)

I.1 – HL-LHC QCD+QGP : for which physics cases ?

1. Measuring QGP temperature = $f(\text{time})$ [low mass e^+e^-]
2. Nature of phase transitions (deconfinement + chirality) :
Connecting to LQCD + asserting Hydrodynamics [ultra low p_T]
3. Understanding in-medium energy loss [Jets shapes and structures]
4. Challenging the flavour dependence of collectivity [s,c,b]
5. Searching for “SM/BSM” [...]

I.2 – HL-LHC QCD+QGP : low mass (e^+e^-) as virtual γ

- QGP temperature = $f(\text{time})$ via thermal virtual photons ($m_{e^+e^-} \in [0;2.5] \text{ GeV}/c^2$)
 high $m_{e^+e^-}$ = high T, i.e. early times



I.3 – HL-LHC QCD+QGP : heavy-flavours facing collectivity

Λ_c^+ ($m = 2.286 \text{ GeV}/c^2$ / $c\tau = 60 \mu\text{m}$)

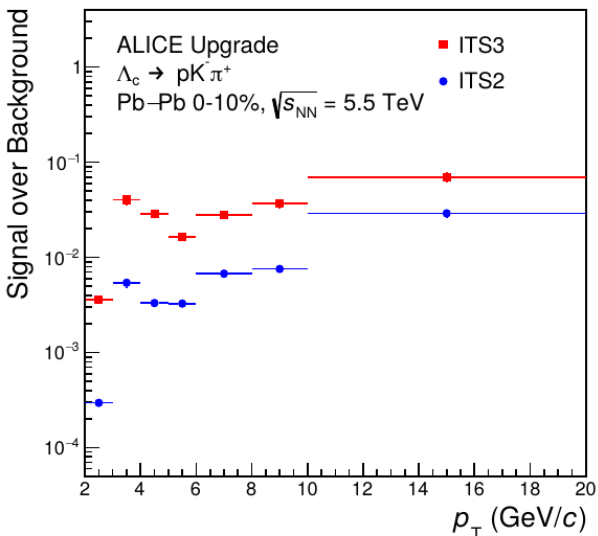
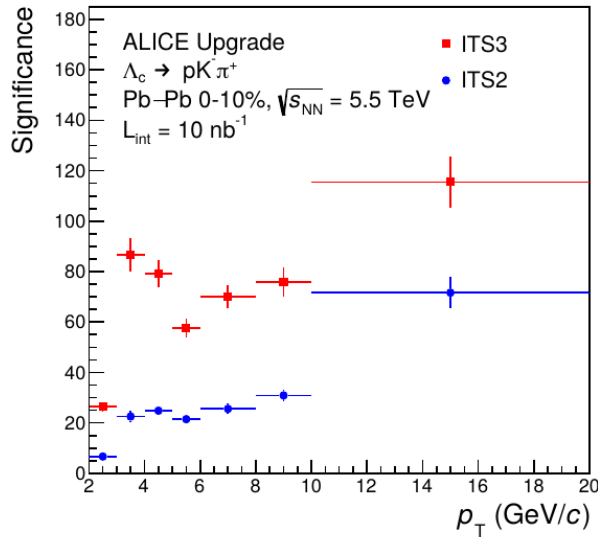


Fig. 13, EoI ITS3, ALICE-PUBLIC-2018-013

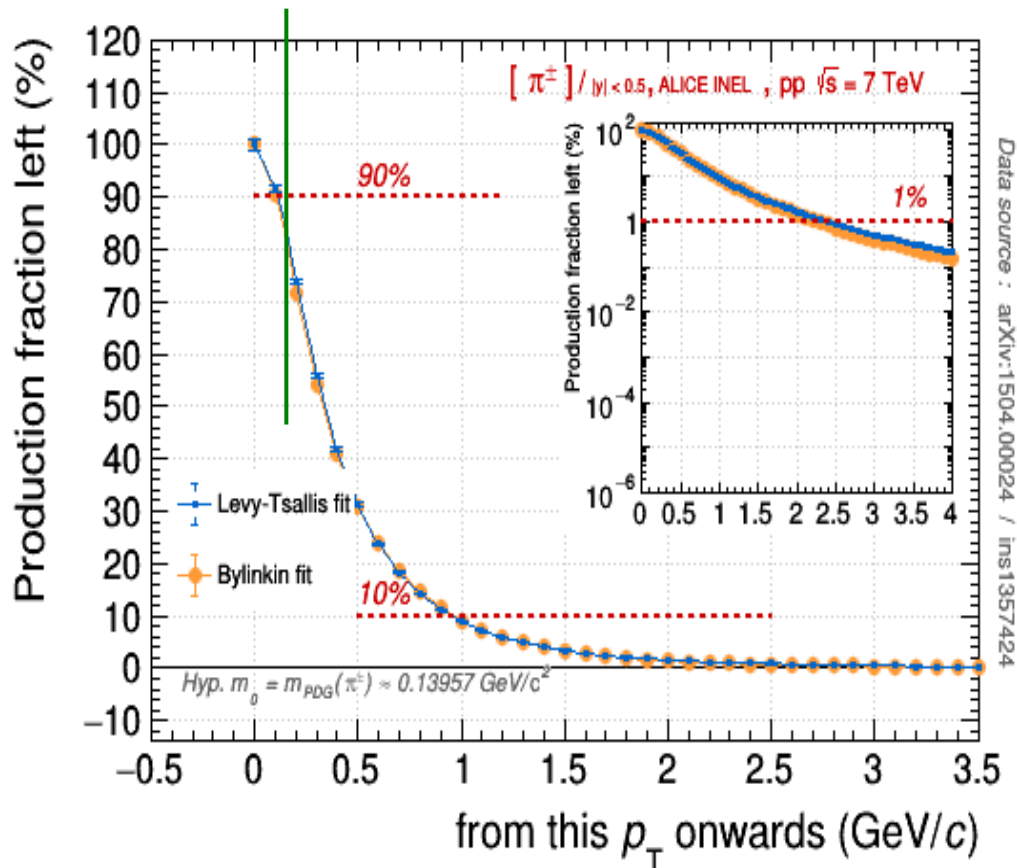
→ diffusion coefficient / hydrodynamization /
in-medium energy loss / hadronisation

- total charm cross-section $c\bar{c}$:
 $\eta_c(1S), J/\psi, \psi(2S), \chi_{Cj} + D^0, D^+, D_s^+, D(2010)^\pm + \Lambda_c^+$
- beauty :
baryons $\Lambda_b^0 \rightarrow \Lambda_c^+ \pi^-$
mesons $B^0 \rightarrow D^- \pi^+, B^\pm \rightarrow D^0 \pi^\pm, B_s^0 \rightarrow \text{non-prompt } D_s^+$
- recombination :
 $p/\pi^+ \rightarrow \Lambda/K_s^0 \rightarrow \Lambda_c^+/D^+ \rightarrow \Lambda_b^0/B^0$
- charm-strange baryons
($c\tau \sim 30\text{-}130 \mu\text{m} + 2\text{-to-}6$ final states cascade decays) :
 $= \Lambda_c^+(udc), \Xi_c^+(usc), \Xi_c^0(dsc), \Omega_c^0(ssc), \Xi_{cc}^{2+}(ucc), \dots, \Omega_{ccc}^{2+}(ccc)$
- charm hypernuclei, c -deuteron = $\Lambda_c n$ bound state
- tetraquark $X(3872) \rightarrow J/\psi \pi^+ \pi^-$

I.4 – HL-LHC QCD+QGP : low- p_T π^\pm

If your $\pi^+(u\bar{d}) / K^+(u\bar{s}) / p(uud)$... measurements start above 0.0, 0.1, 0.2 ... GeV/c, how much (x%) of the total dN/dy in pp do you miss ?

For a given particle type of interest, can you claim a “precision measurement” if you indeed miss x% of production ? \rightarrow yes or no ? to be decided, case by case...



NB : ALICE pp 7 TeV [arXiv:1504.0024](https://arxiv.org/abs/1504.00024)

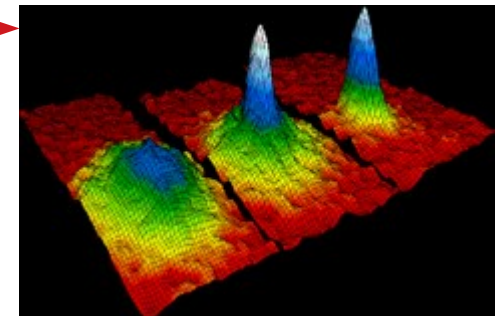
$h^\pm > 0.15$ GeV/c \rightarrow Missed cross-section $\approx 15\%$

$\pi^\pm > 0.10$ GeV/c \rightarrow Missed cross-section $\approx 10\%$

I.5 – HL-LHC QCD+QGP : why caring about the low- p_T π^\pm

1. Getting $dN/dp_T dy + v_n(h^\pm)$ down to non-relativistic p_T (e.g. $p_T < 0,05 \text{ GeV}/c \rightarrow \beta_\pi^\pm \approx 0,34$)
 \rightarrow change from non-relativistic (linear) to relativistic hydro. (quadratic behaviour)

2. Chiral disoriented condensate + π condensate
 if present, $p_T < 1/2 m_\pi$



Wikipedia: Bose-Einstein condensate

3. Net quantum numbers fluctuations at ($\mu_B = 0$)

Q : net charge ($h^+ - h^-$),

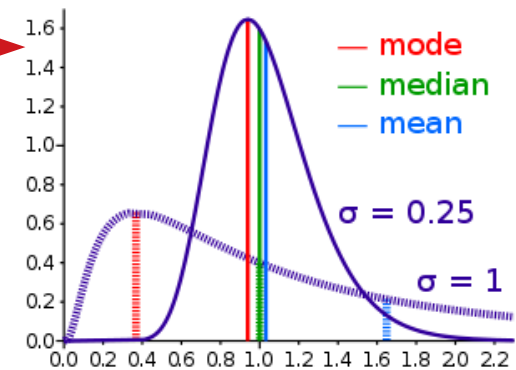
B : net baryon ($p - \bar{p}, \Lambda - \bar{\Lambda}, \dots$)

S : net strangeness ($K^+ - K^-, \Lambda - \bar{\Lambda}, \dots$)

Measure event-by-event fluctuations into distributions

with $p_T > 0 \text{ GeV}/c$, over large y :

- 1st moment, m_1 : mean μ
- 2nd moment, m_2 : std deviation
- 3rd moment, m_3 : skewness
- 4th moment, m_4 : kurtosis
- 5th moment, m_5 : *no name*
- 6th moment, m_6 : ...
- 7th moment, m_7 : ...

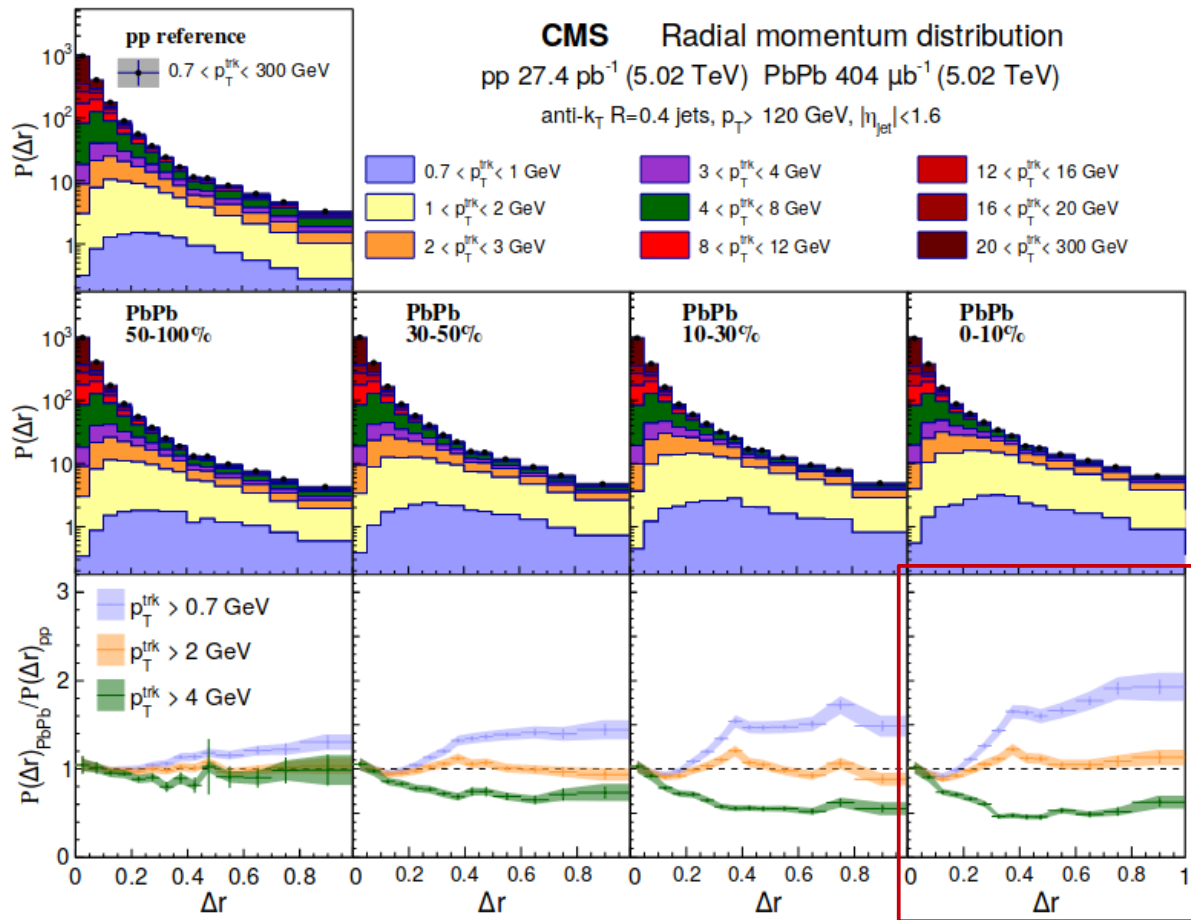


Wikipedia:Skewness

\rightarrow *one key (today)* : ratio m_6/m_4 to access direct comparison to LQCD for
 (deconfinement dof + transition + chiral restoration)

I.6 – HL-LHC QCD+QGP : jet in charged jets...

CMS Pb-Pb 5.02 TeV arXiv:1803.00042



(0-10% AA)/pp diff = important at :
 - large Δr (Δr > 0.4)
 ← - low p_{T,track} (p_T < 1 GeV/c)

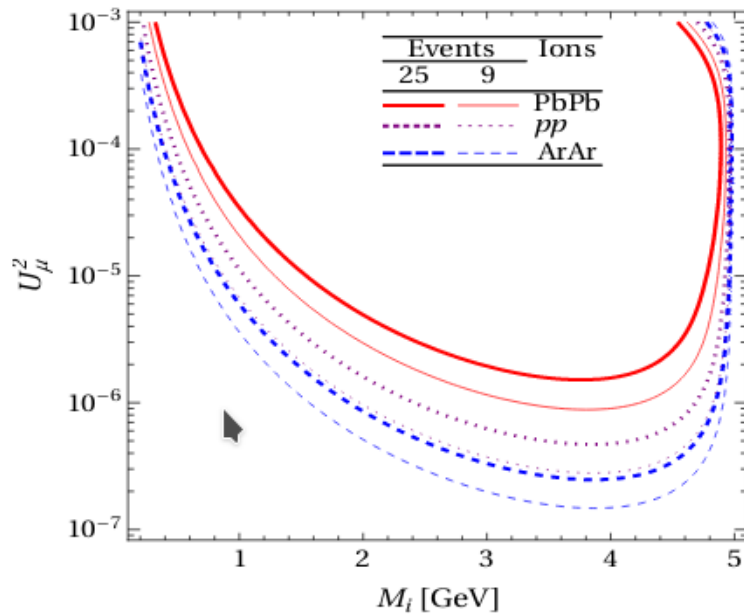
→ (hyper)fine structure/shape jets flavour jet-tagging (g Vs. q, c Vs. b)

I.7 – HL-LHC QCD+QGP : SM/BSM searches

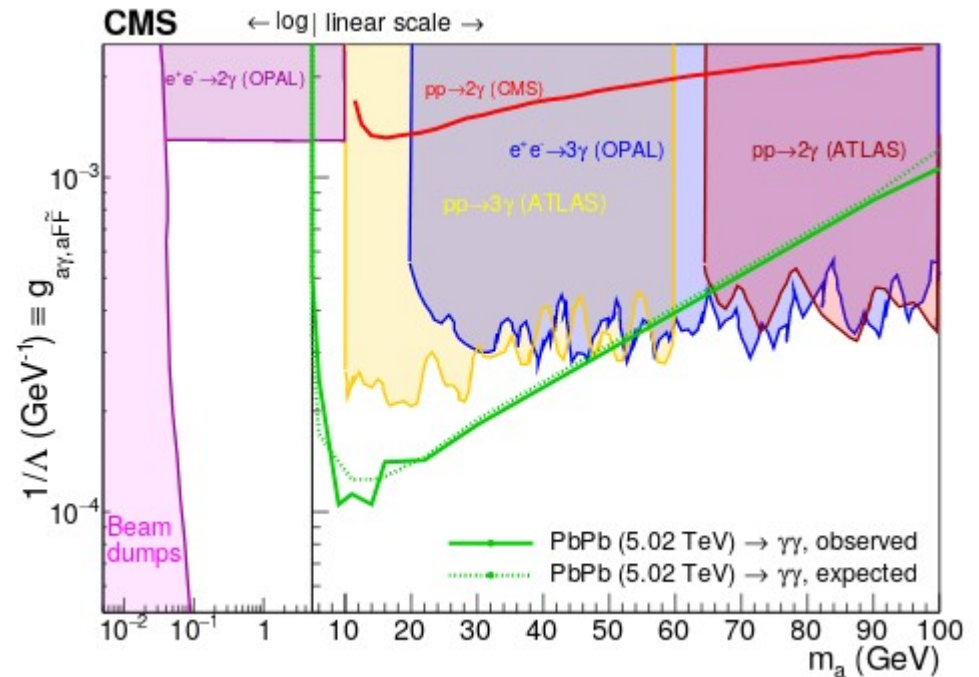
- axion-like particle (ALP) in UPC light by light,
- Long-lived particles,
- sexaquarks
- magnetic monopoles

...

d'Enterria ESPP, arXiv:1812.07688

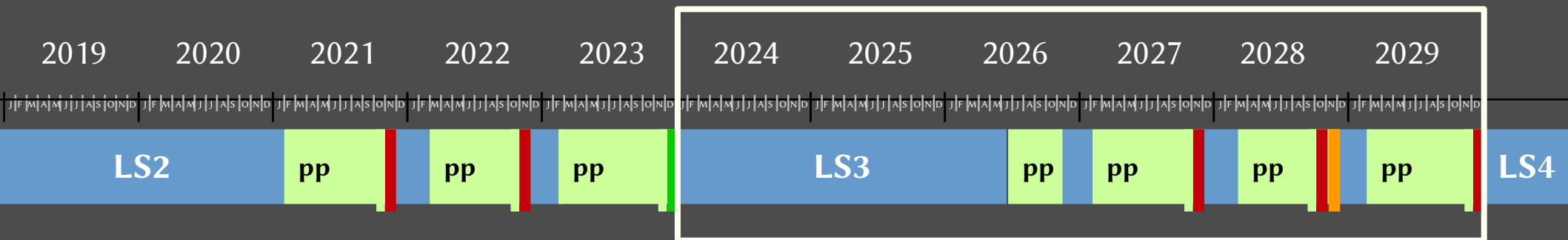


Heavy neutrino searches in B decays



*Current 95% CL exclusion limits
ALP coupling to γ Vs ALP mass*

Part B – ITS-3 = after LS3 (≥ 2026 , Run 4)



LHC running plan

III.1 – ITS-3 : first expression of interest

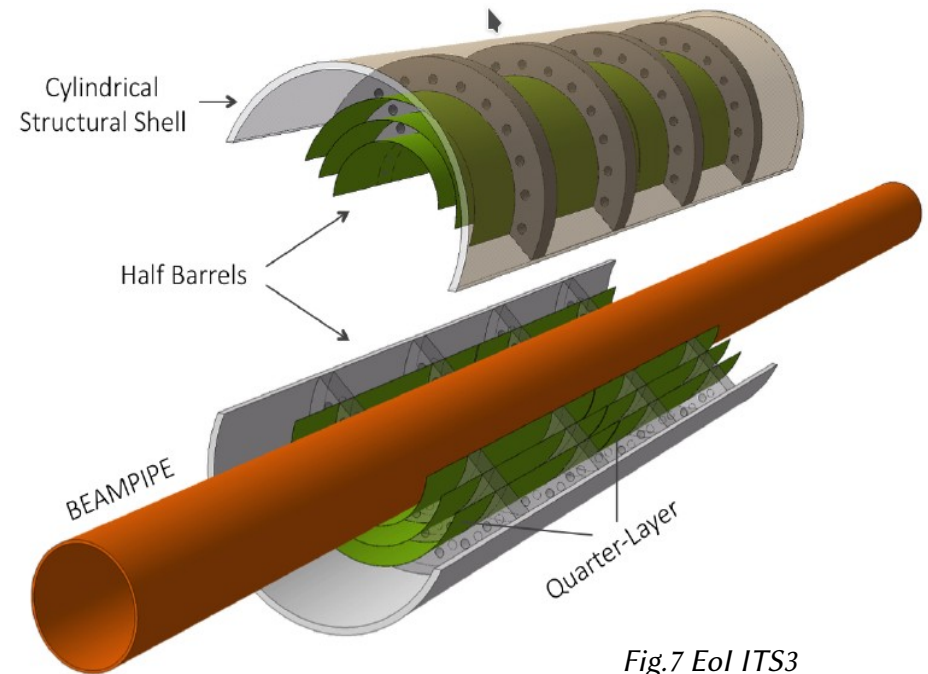
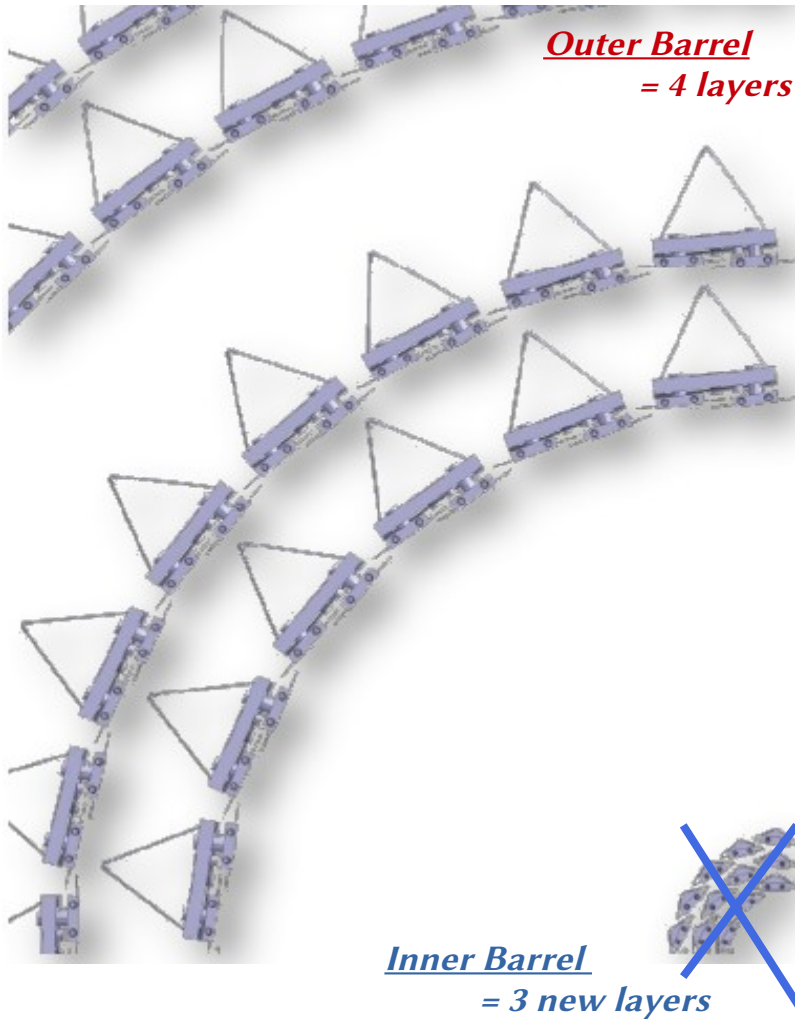


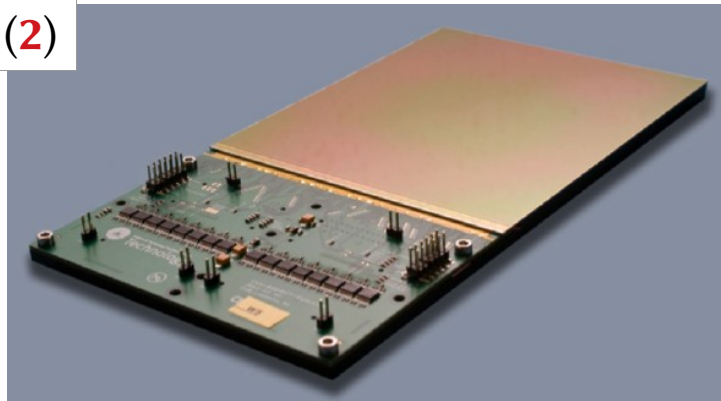
Fig.7 EoI ITS3
ALICE-PUBLIC-2018-013

III.2 – ITS-3 : key foreseen features, “closer + lighter”

Keys :

- (1) - shrunk beam pipe ($r_{\text{beam pipe}} = 1.6 \text{ cm}$)
→ inner most layer at $r_{L0} = 1.8 \text{ cm}$
- (2) - reticle-size sensor ($O[15 \times 10 \text{ cm}^2]$)
- + (3) - ultra-thin Si CMOS ($\leq 40\text{-}\mu\text{m}$ thick)
 - circuitry pushed to periphery (*stitching*), ~no extra services required
 - can be curved
 - homogeneous $0.05\% \text{ X/X}^\circ$ per layer

(2)

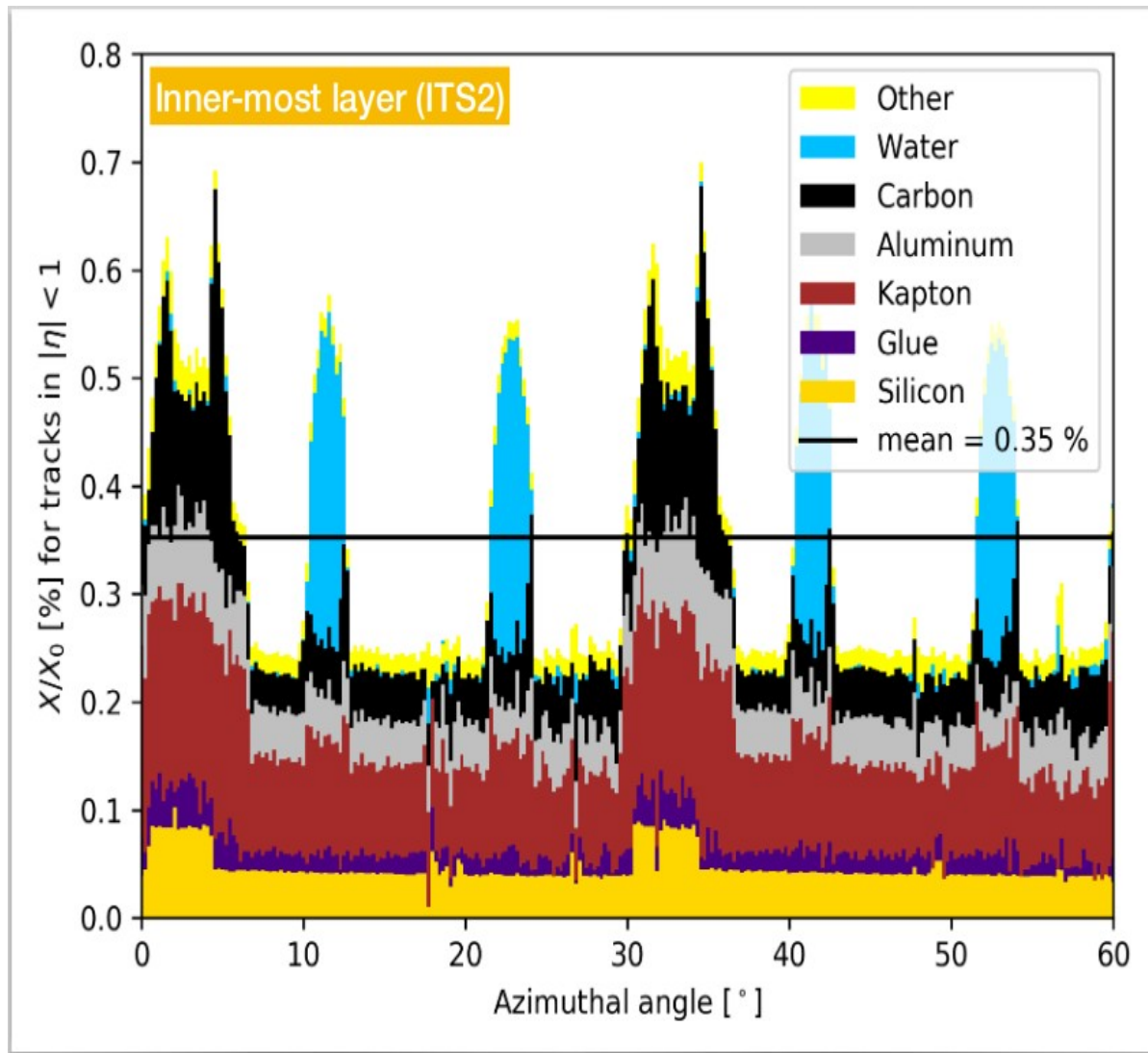


X-ray detector $13.9 \times 12 \text{ cm}^2$ TowerJazz $0.18\text{-}\mu\text{m}$

(3)



III.3 – ITS-3 : skimming material budget of ITS-2



→ Si only 1/7th of total material

→ irregularities due to overlaps + support/cooling

III.3 – ITS-3 : skimming ITS-2



→ Si only 1/7th of total material

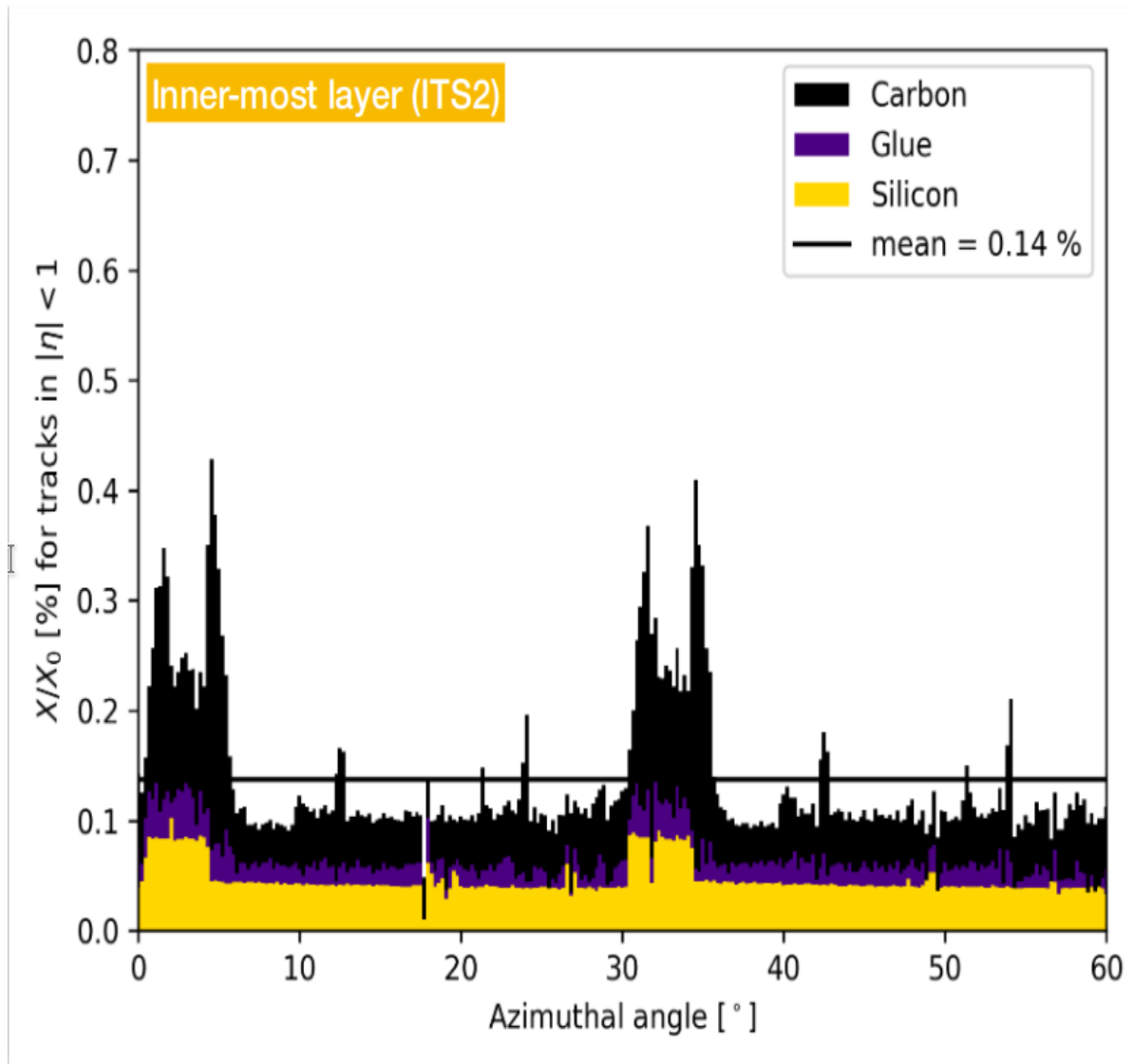
→ irregularities due to overlaps + support/cooling

→ remove water cooling

→ possible by reducing power consumption in fiducial volume to $< 20 \text{ mW/cm}^2$

1.

III.3 – ITS-3 : skimming ITS-2



→ Si only 1/7th of total material

→ irregularities due to overlaps + support/cooling

→ remove water cooling

1.

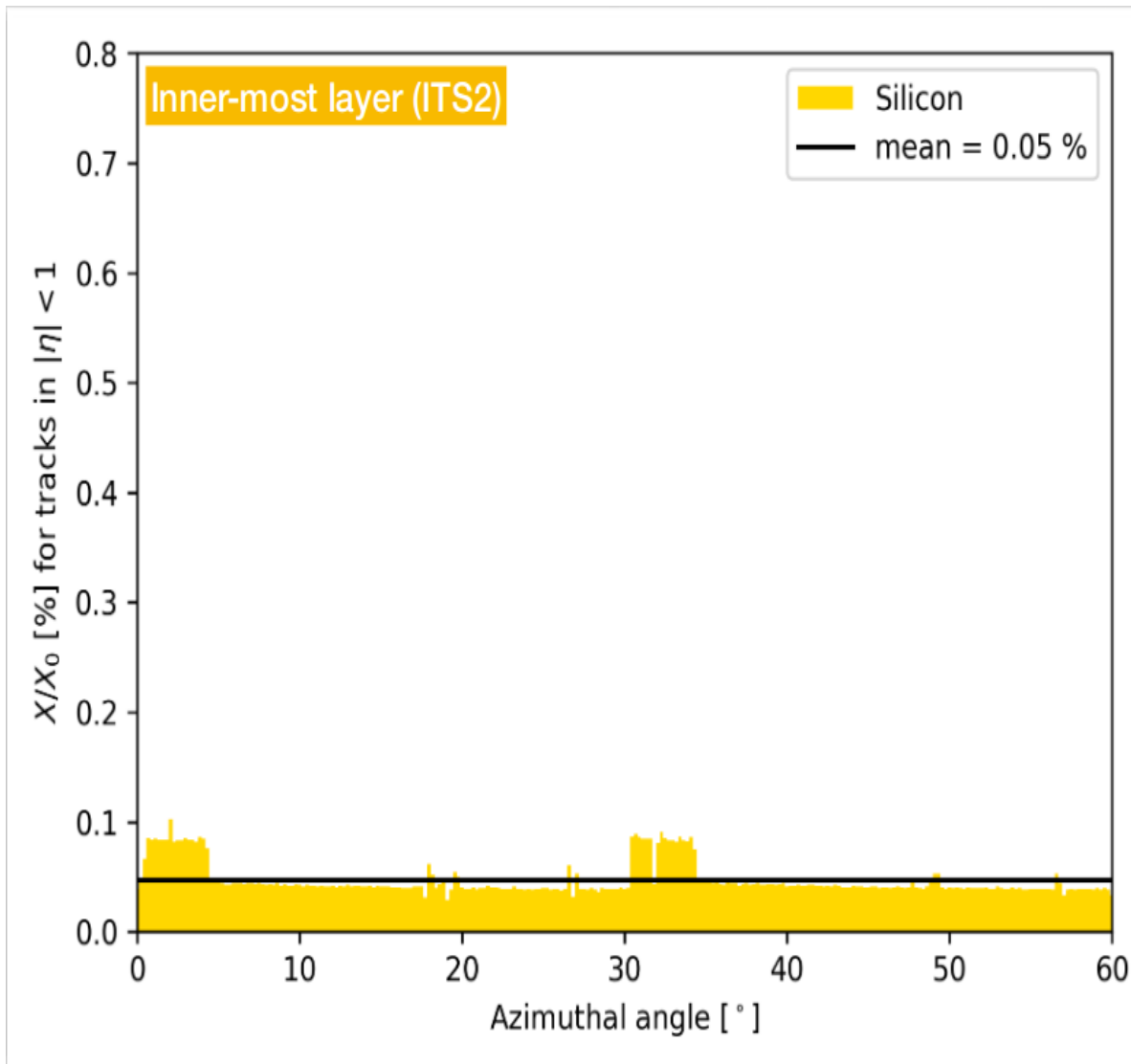
→ possible by reducing power consumption in fiducial volume to $< 20 \text{ mW/cm}^2$

→ remove external data lines + power distribution

2.

→ possible by making a single large chip and that for distribution

III.3 – ITS-3 : skimming ITS-2



⇒ Si only 1/7th of total material

⇒ irregularities due to overlaps + support/cooling

⇒ remove water cooling

1.

⇒ possible by reducing power consumption in fiducial volume to $<20 \text{ mW/cm}^2$

⇒ remove external data lines + power distribution

2.

⇒ possible by making a single large chip and that for distribution

⇒ move mechanical support outside acceptance

3.

⇒ benefit from increased stiffness by rolling Si wafers

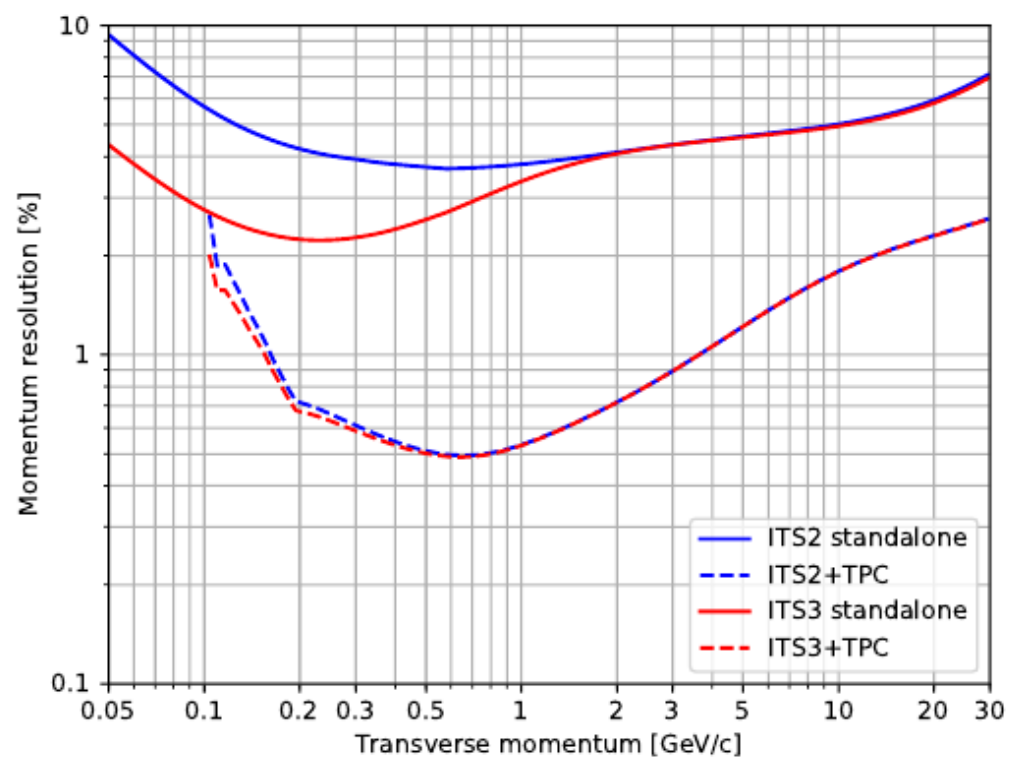
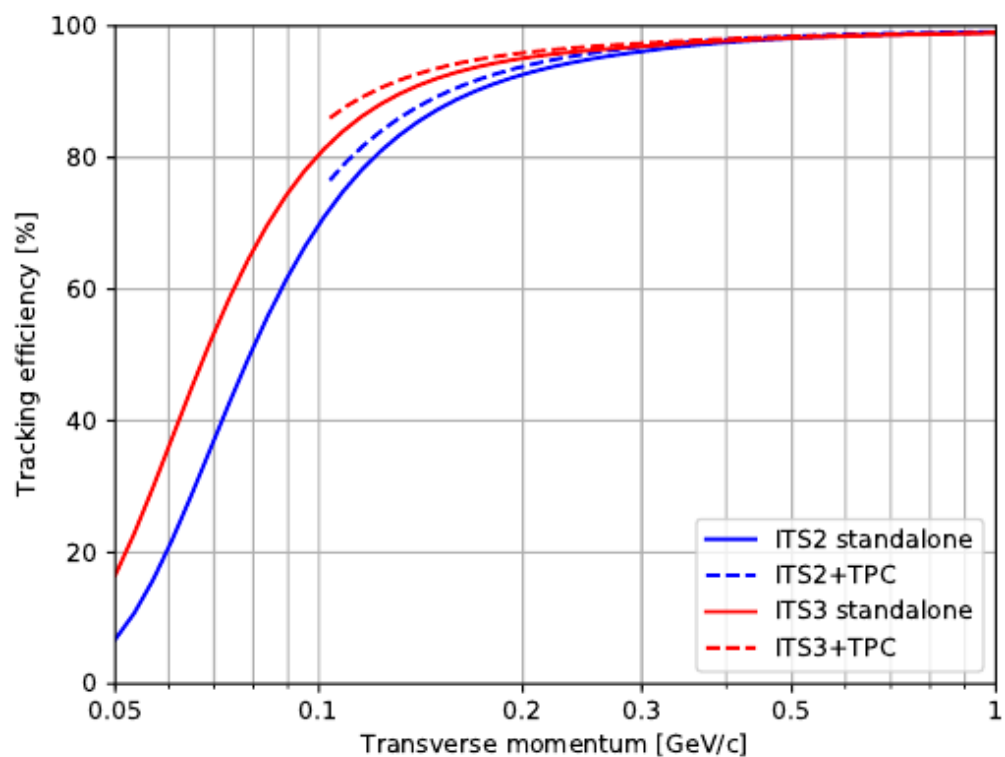
III.4 – ITS-3 : synoptic table

	ITS1 (SPD = 2 inner)	ITS2 (3 inner)	ITS3 (3 inner)
Beam pipe inner radius/thickness	3.0 cm/0.09 cm	1.82/0.08 cm	1.6/0.05 cm
First-layer radius	3.9 cm	2.3 cm	1.8 cm
X/X° per layer	1.1 %	0.35 %	0.05%
$ \eta $ coverage	> 1.4	> 2.0	> 2.0
Number of Sensors per layer	80+160	108+144+180	2* to 4
Technology	Hybrid pixels	CMOS	CMOS
Trigger ?	yes	no	not foreseen
Pixel size $r_\phi \times z$	$\approx 50 \times 425 \mu\text{m}^2$	$\approx 30 \times 30 \mu\text{m}^2$	* $\approx 15 \times 15 \mu\text{m}^2$
Intrinsic resolution r_ϕ / z	12 μm / 100 μm	5 μm / 5 μm	$\leq 5 \mu\text{m}$ / 5 μm
Readout frequency Pb-Pb	< 3 MHz > 300 ns (SPD)	< 50-100 kHz > 20-10 μs	$\approx \geq 1 \text{ MHz}^*$ $\approx \leq 1 \mu\text{s}^*$
Power dissipation in the pixel <i>matrix</i>	$\approx 550\text{-}736 \text{ mW/cm}^2$ i.e. liquid cooled	$\sim 40 \text{ mW/cm}^2$, i.e. liquid cooled	$\sim 7 \text{ mW/cm}^2$, i.e. air flow

* if CMOS with the 0.065- μm technology, instead of the current (=ITS-2) 0.180- μm

III.5 – ITS-3 : why would you invest into it ?

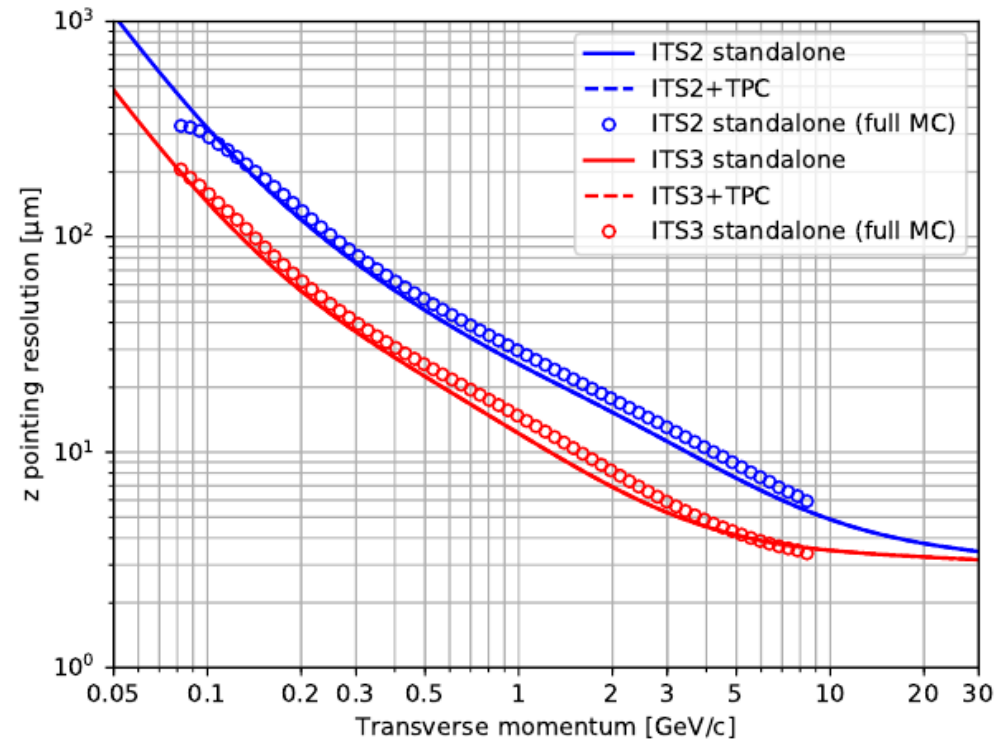
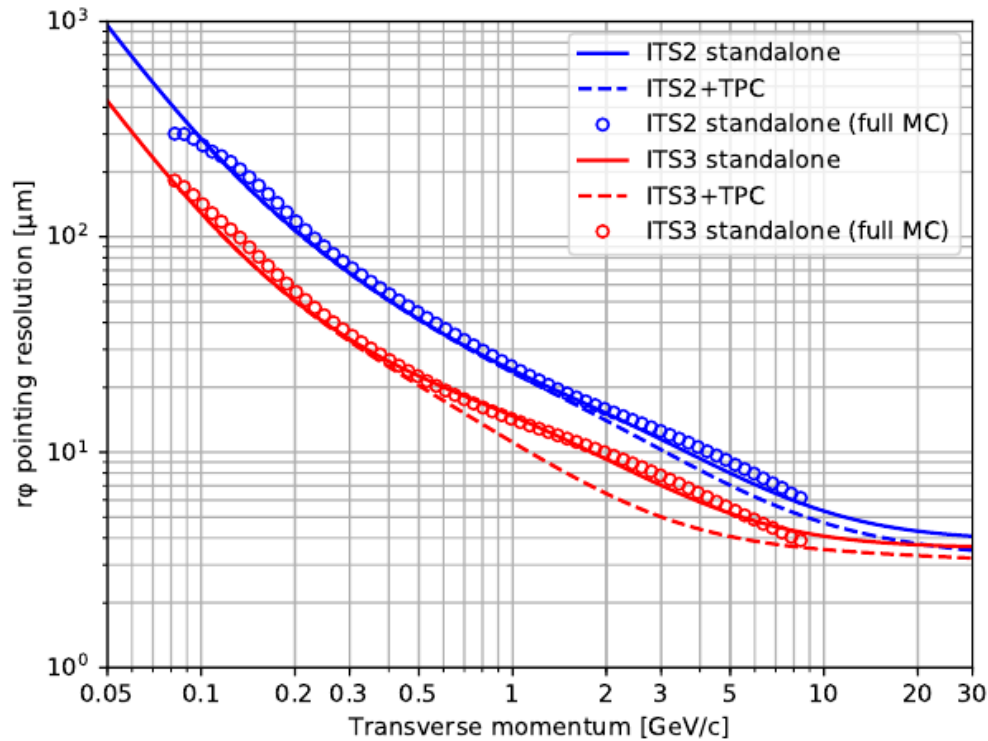
Fig.12, EoI ITS-3, ALICE-PUBLIC-2018-013



Pb-Pb 0-10% $\sqrt{s_{NN}} = 5.5$ TeV
(Fast MC tracking tool...)

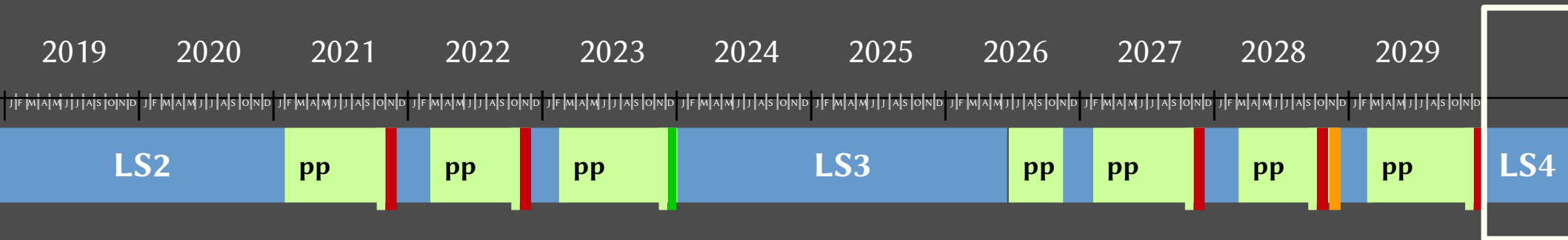
III.6 – ITS-3 : why would you invest into it ?

Fig.11, EoI ITS3, ALICE-PUBLIC-2018-013



Pb-Pb 0-10% $\sqrt{s_{NN}} = 5.5 \text{ TeV}$

Part E – All-Si = after LS4 (≥ 2031 , Run 5)



V.1 – All-Si : “LS4+” = “ITS4” = “ANGHIE”

EoI A Next Generation Lhc heavy-ion Experiment LS4+, [arXiv:1902.01211](https://arxiv.org/abs/1902.01211)
 + SQM 2019 L.Musa [Indico.cern.ch/e/755366/c/3428151/](https://indico.cern.ch/e/755366/c/3428151/)

- Tracking over : $|\eta| < 4 + (p_T > 30-50 \text{ MeV}/c \text{ at } y=0)$
- space resolution $\approx < 5 \mu\text{m}$

A new experiment based on a “all-silicon” detector



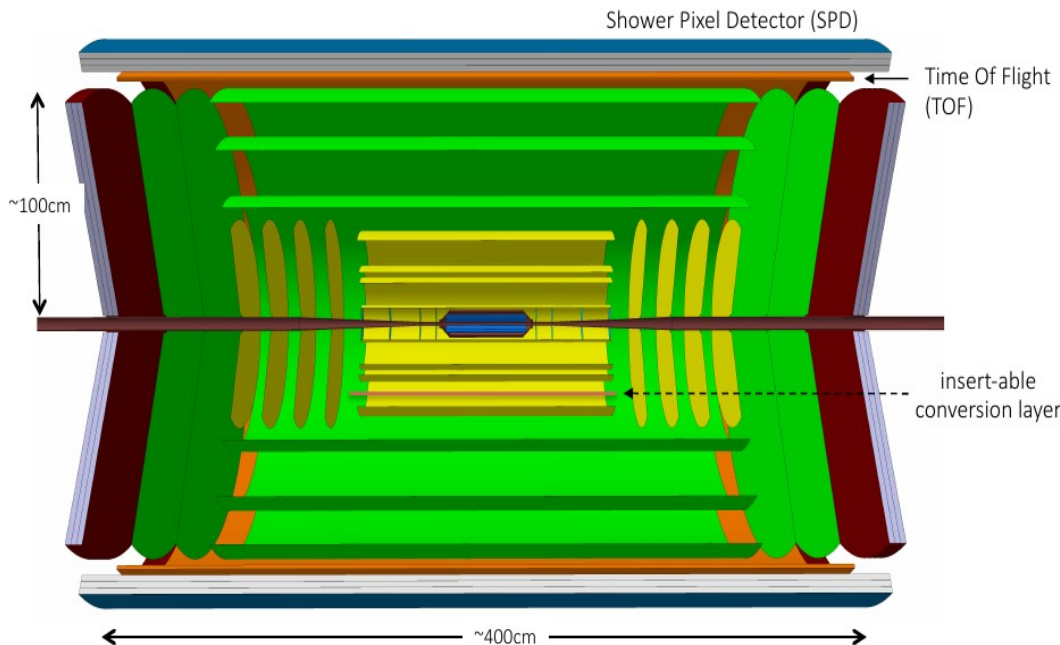
- e^\pm and γ tag
 $(p_T > 30-50 \text{ MeV}/c)$

Tracker: ~ 10 tracking barrel layers (blue, yellow and green) based on CMOS sensors

Particle ID:

- TOF with outer silicon layers (orange)
- Shower Pixel Detector (outermost blue layer)

Extended rapidity coverage: **up to 8 rapidity units**



Magnetic Field

- $B = 0.5$ or 1 T

Spatial resolution

- Innermost 3 layers: $\sigma < 3 \mu\text{m}$
- Outer layers: $\sigma \sim 5 \mu\text{m}$

Vertex material thickness

- $X/X_0 \sim 0.05\% / \text{layer}$

Time Measurement

Outermost layer integrates high precision time measurement
 $(\sigma_t \sim 20\text{ps})$

Conclusion

Now +10-year horizon = blur ?

→ future of QCD/QGP physics = via precision measurements for sure.

No escape.

ALICE choice : roadmap paved with LS2 upgrades (≥ 2021)

with a stress given to :

i) PID and low p_{\perp} ($0 < p_{\perp} < O(10) \text{ GeV}/c$)

ii) flavour mapping (Light/Heavy Flavours : differences ? Similarities ?)

Such a physical roadmap = proposed to be extended with ITS3 (≥ 2026),

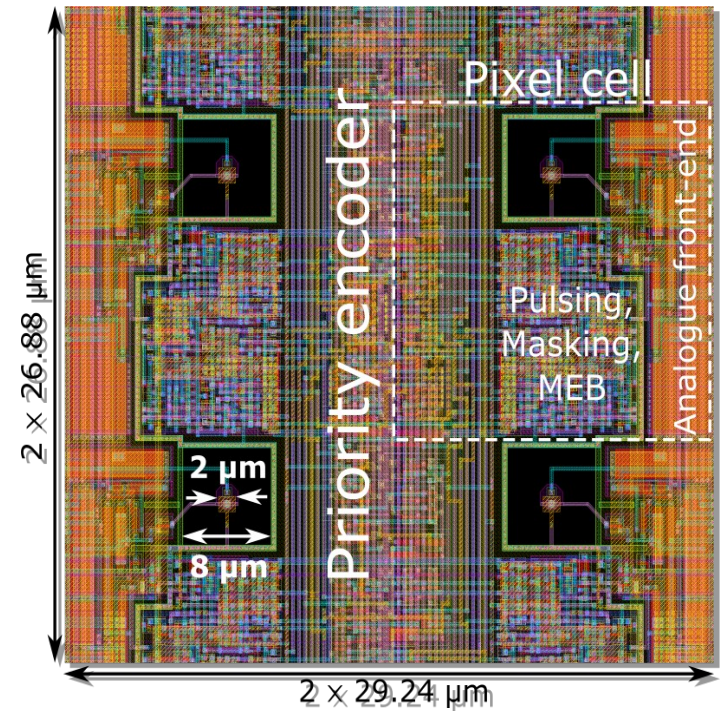
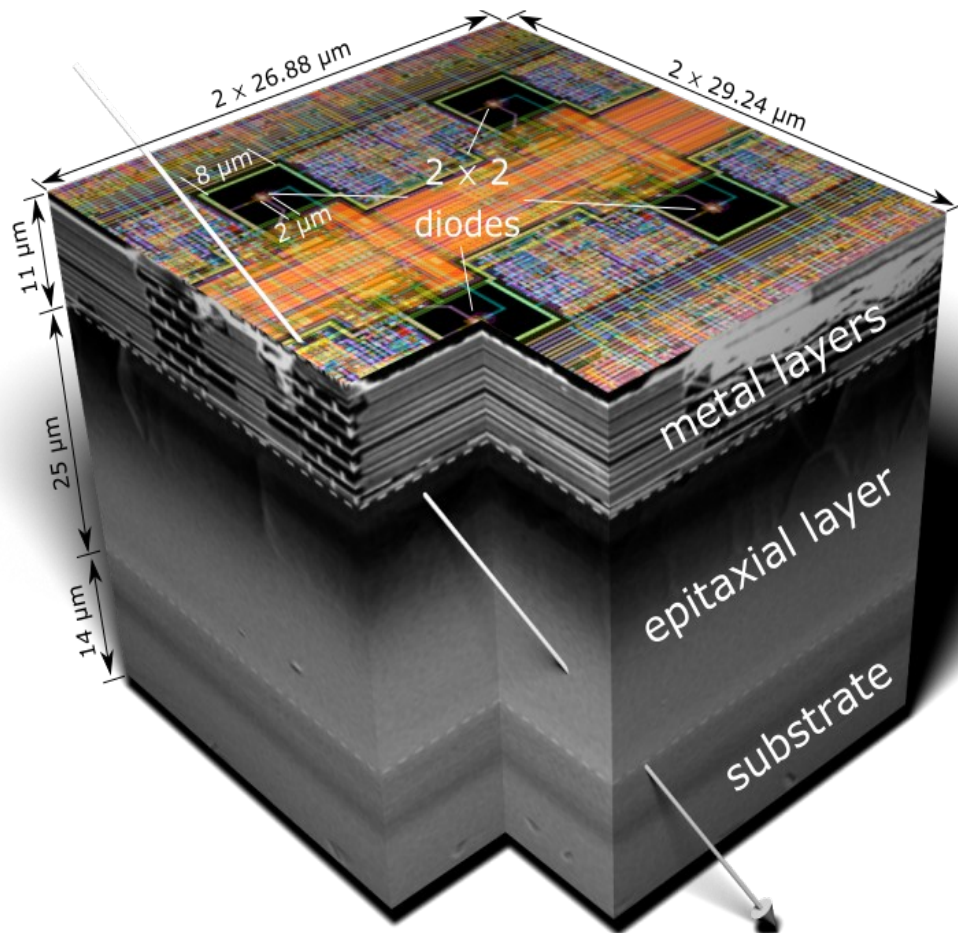
in order to bridge a gap towards an all-Si experiment (≥ 2030)

Appendices

Part A – CMOS, the basic tool

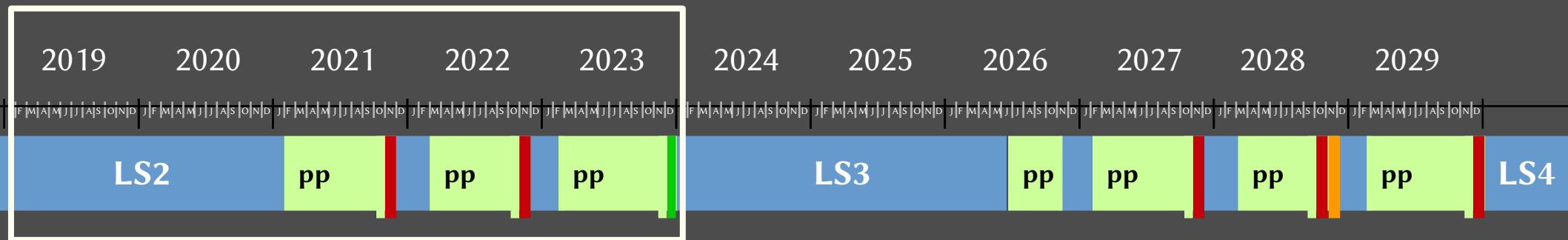
I.2 – Pixel detectors : ALPIDE chip

Sensor using
TowerJazz 0.18 μm CMOS Imaging Process



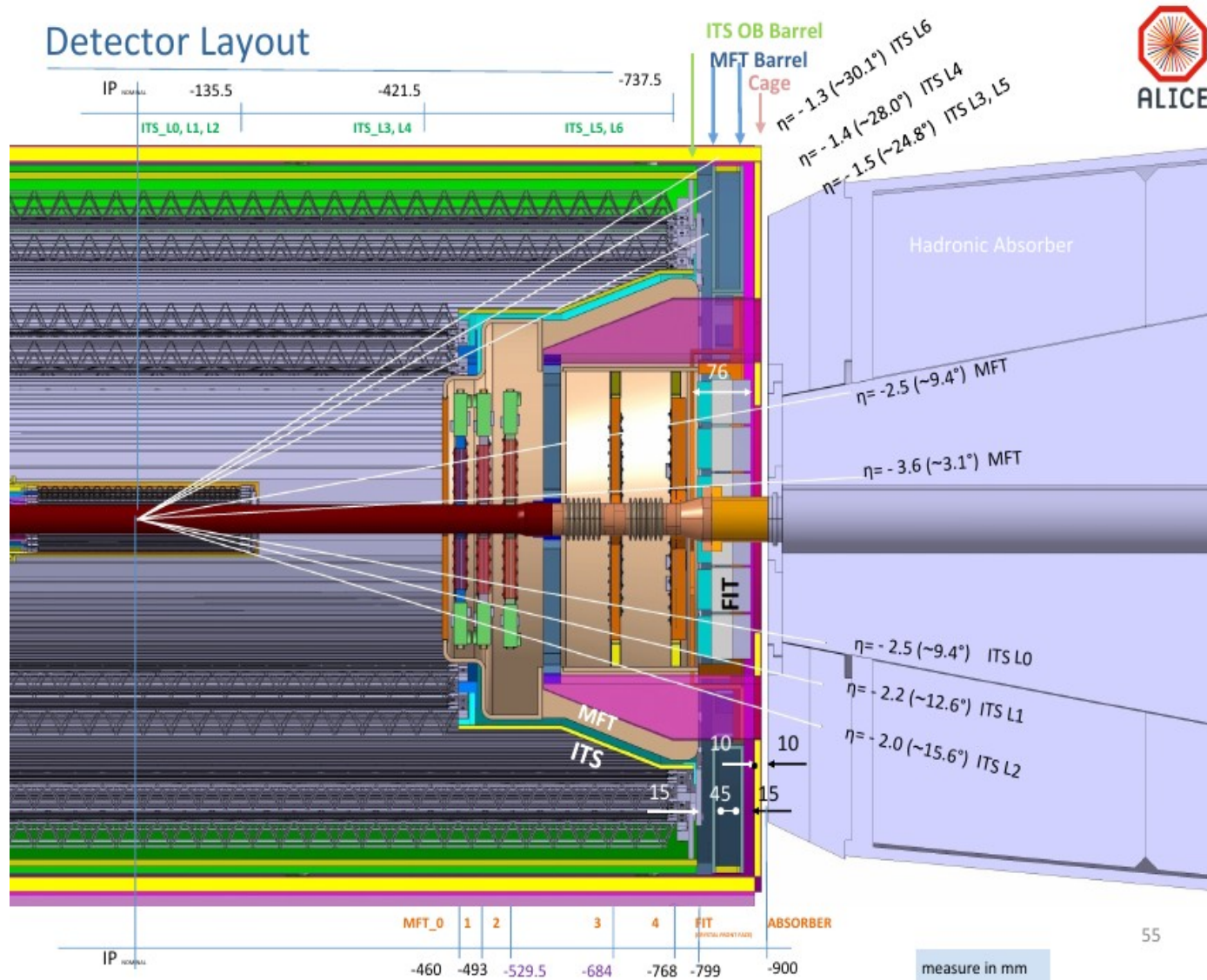
ALPIDE – 3D and 2D views of 2x2 pixels
(Here, in the 50- μm -thick version...)

Part B – ITS-2 = after LS2 (≥ 2021 , Run 3)



LHC running plan

II.1 – ITS-2 + MFT : MAPS-based detector

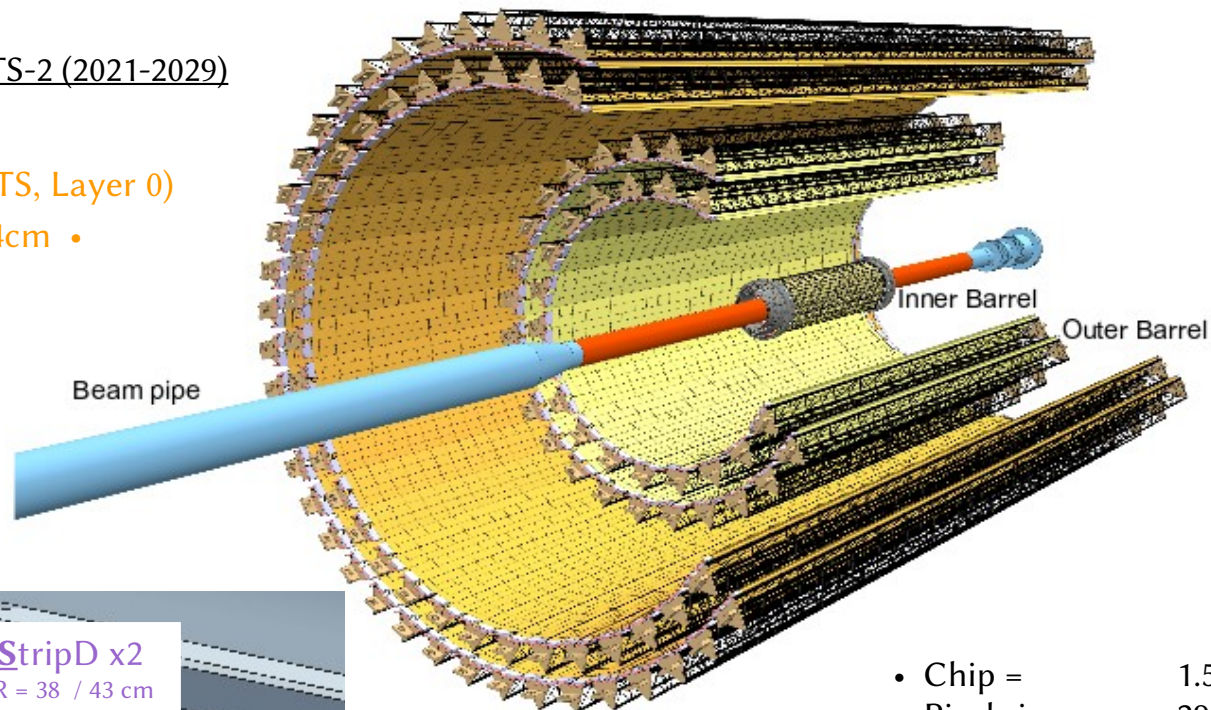


II.2 – ITS2 : ALICE upgrade ITS, few figures

ITS-2 (2021-2029)

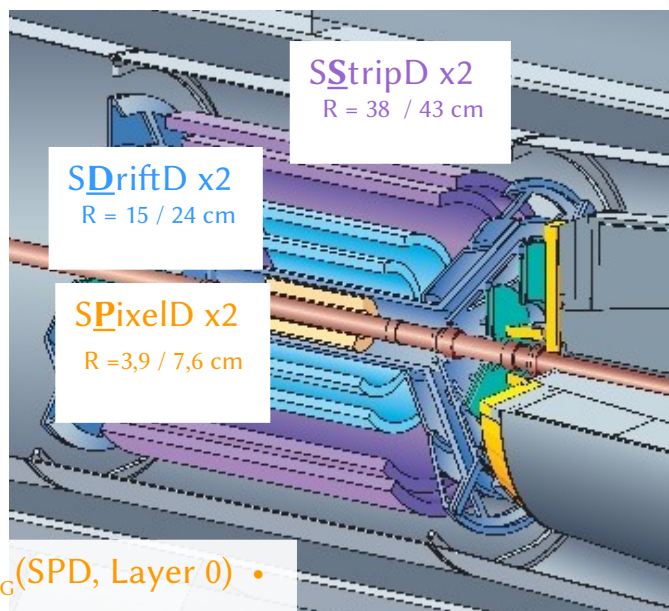
R_{AVG} (uITS, Layer 0)
= 2.34cm •

Beam pipe : $R_{upgrade}$ 1.82 cm •



- 7 pixel-only layers
- 12.6×10^9 pixels,
- $\sim 10 \text{ m}^2$ in total
- 13.6×10^6 CHF
(0.18- μm CMOS technology by TowerJazz)

ITS-1 (2009-2018)



SStripD x2
 $R = 38 / 43 \text{ cm}$

SDriftD x2
 $R = 15 / 24 \text{ cm}$

SPixelD x2
 $R = 3,9 / 7,6 \text{ cm}$

R_{AVG} (SPD, Layer 0) •
= 3.9 cm

• Beam pipe :
 $R_{current} = 2.9 \text{ cm}$

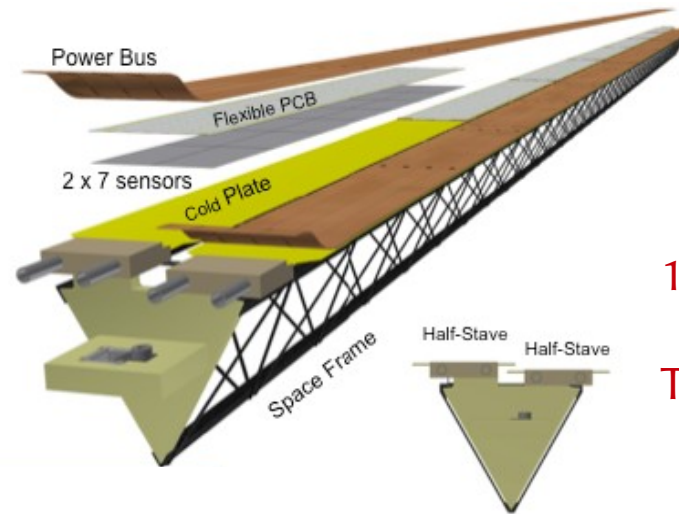
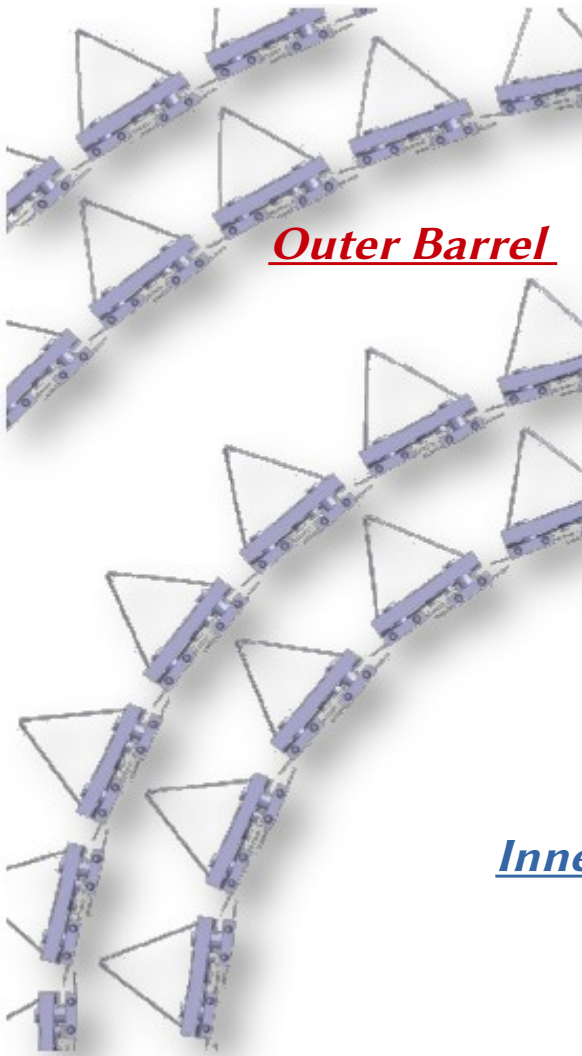
- Chip = $1.5 \times 3 \text{ cm}^2$
- Pixel size = $29 \times 27 \mu\text{m}^2$
(current SPD : $50 \times 425 \mu\text{m}^2$)

Note :

No dE/dx information,
binary pixel readout “0/1”

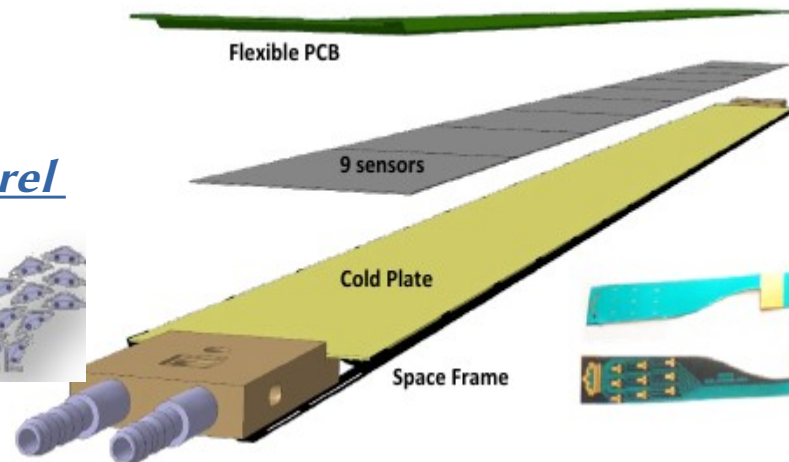
Unlike “past” ITS-1 with SDD, SSD...

II.3 – ITS2 : “(half)-stave of modules of chips”



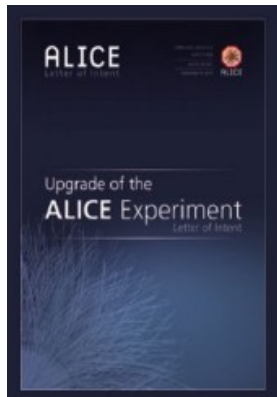
1 module = 2x7 chips
≈ 3 cm x 21 cm ,
Then, up to 7 modules to build half-stave

Inner Barrel



1 module
= 9 chips in a raw,
≈ 1.5 cm x 27 cm
directly put on stave

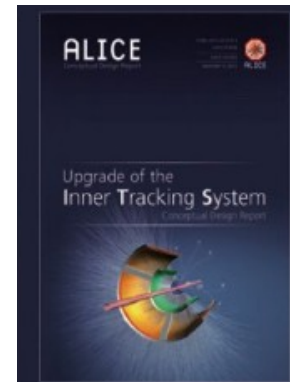
A.1 – Beyond LS2 : TDRs for run 3+4 detectors



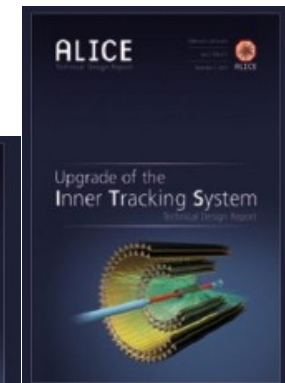
CERN-LHCC-2012-012



CERN-LHCC-2013-020



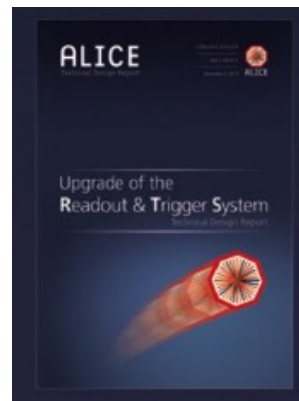
CERN-LHCC-2012-005



CERN-LHCC-2013-024



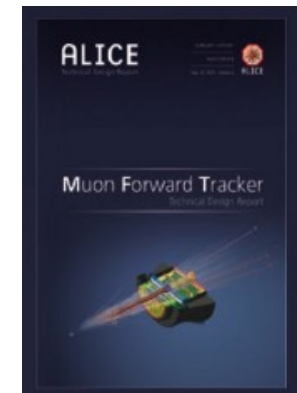
CERN-LHCC-2015-006



CERN-LHCC-2013-019

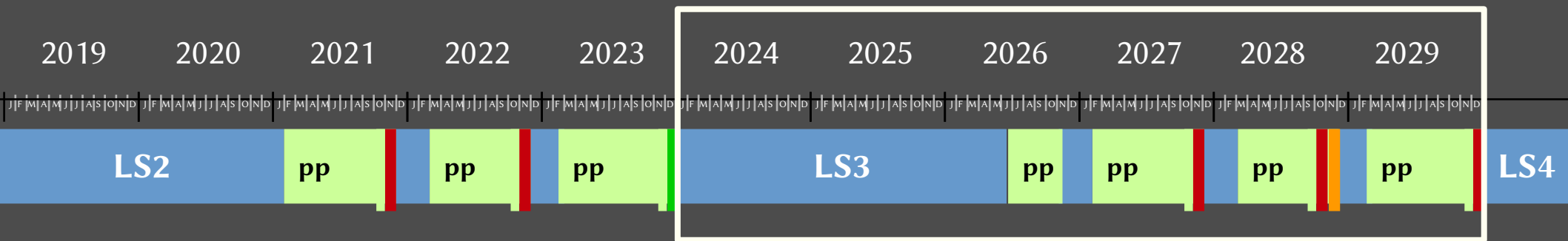


CERN-LHCC-2013-014



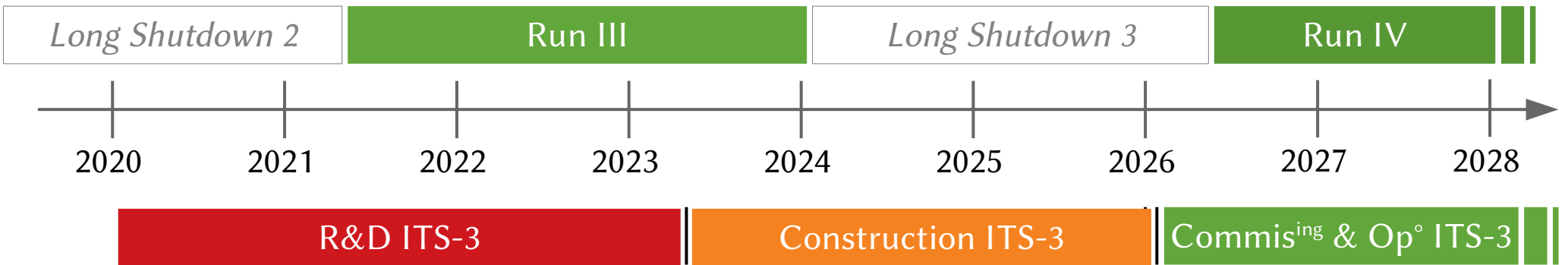
CERN-LHCC-2015-001

Part C – ITS-3 = after LS3 (≥ 2026 , Run 4)



LHC running plan

III.4 – ITS-3 : 5.3 kCHF up to 2025



• Wafer thinning and bending

2019: contact industry

2019-20 : 1st prototype with ALPIDE chips + wafers

>2020 : specific prototype

• Development of stitched sensor

2019-20 : technology test structures

2020-22 : prototyping chips

2022-23 : full-scale prototype + final chip

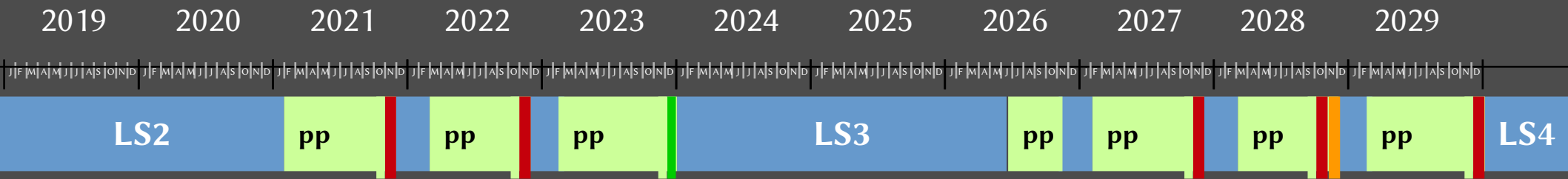
→ *Tech. Design Report + Physics Perf* = 2022

• Construction : 2024-25 = 3x2x2 sensors

Table 8: Project cost estimate breakdown (kCHF).

Item	R&D	Construction	Total Cost
Total	≈ 35% 1900	3400	5300
Beampipe	600	900	1500 ≈ 28%
Pixel CMOS sensors	600	800	1400
Sensor test	100	150	250
Thinning & bending	200	300	500
Hybrid printed circuit	100	100	200
Mechanics	150	350	500
Assembly & test	50	200	250
Installation & alignment	0	200	200
Air cooling	100	150	250
Services	0	100	100
Patch panels	0	150	150

Part D – why physics with low p_T ?



LHC running plan

IV.2 – ITS*n* : admittedly... but, in more concrete terms, “why” ?

ALICE :

- for “low p_T charmed hadrons and baryons (Λ_C^+ to Ω_{ccc}^{++})”
- for “thermal radiation by the QGP via virtual photons (low-mass e^+e^- $m_{ee} < 2 \text{ GeV}/c$)” !

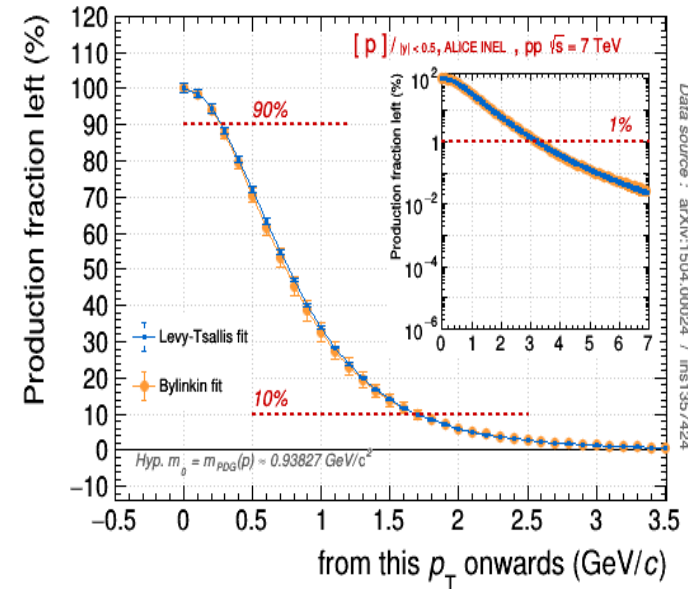
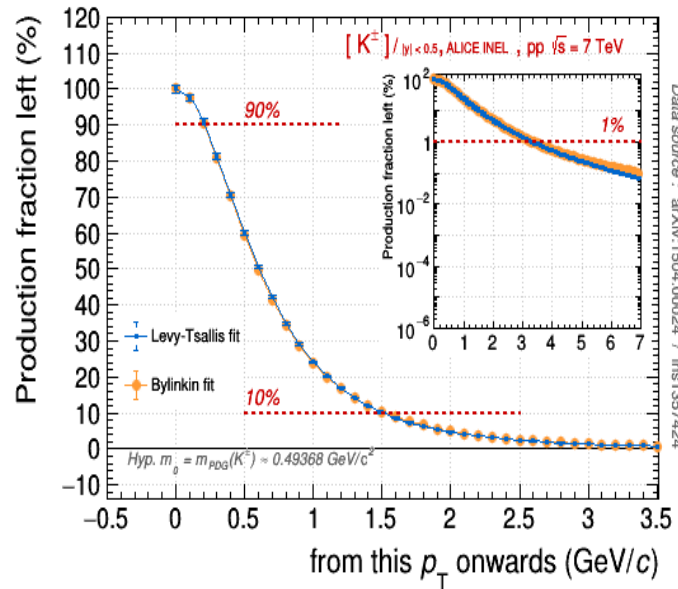
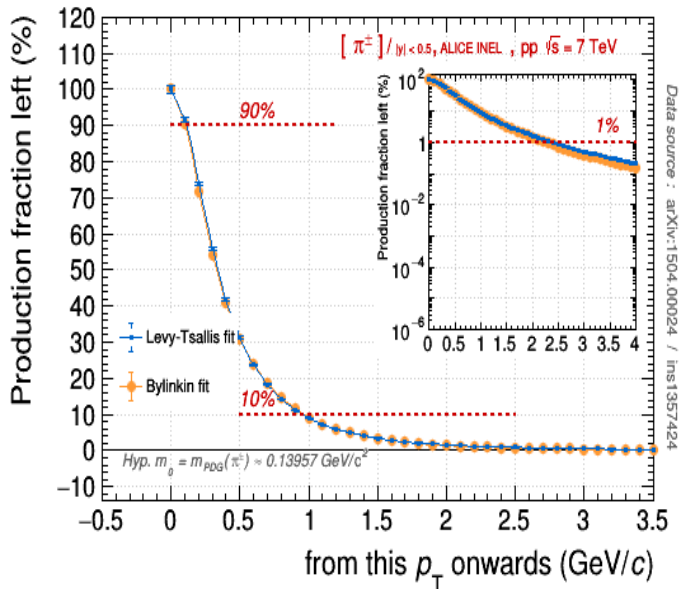
(Wo)man on the HEP street : “Seriously, that’s your physics case to be sold ?!”

→ Consider them as litmus tests :

if one is able to do those two type of measurements,
then you can do many things on top of that.

= Focus given to “ultra low p_T ” detection threshold ($\geq 20\text{-}50 \text{ MeV}/c$),
i.e. push the logic of “scrutinise what is yet abundant” far to the end
in contrast to CMS/ATLAS strategy to fight for the “unseen/rarity”

IV.3 – ITS n : why low p_T ? Simple examples of π, K, p

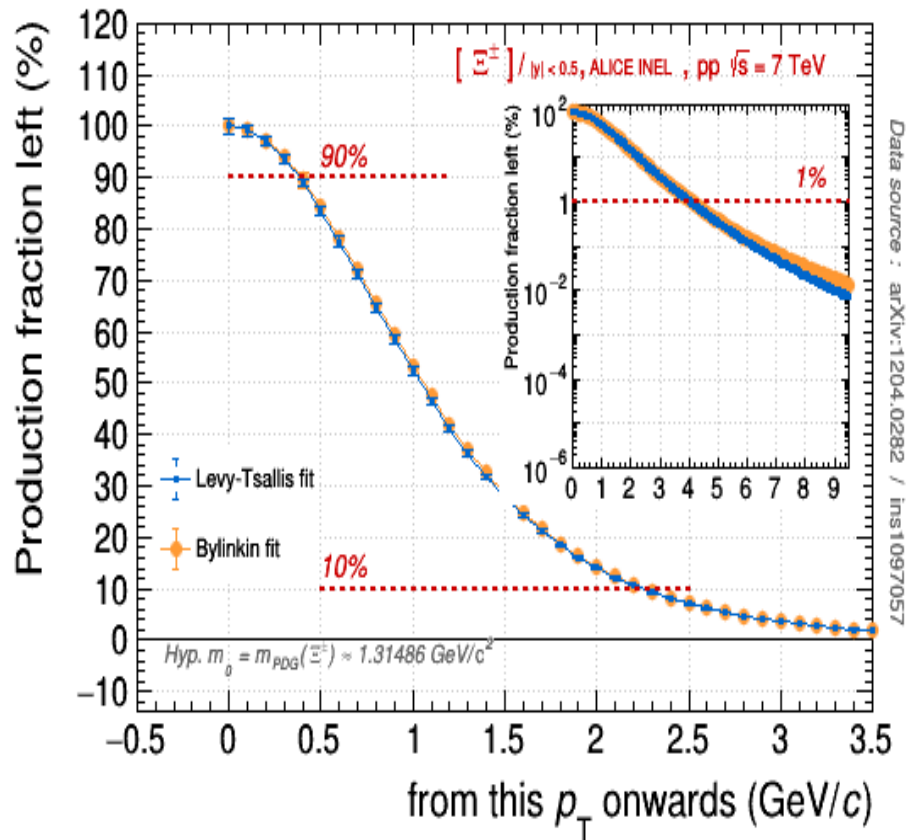


If your $\pi^+(u\bar{d}) / K^+(u\bar{s}) / p(uud)$ measurements start above 0.0, 0.1, 0.2 ... GeV/c, you miss $x\%$ of the total dN/dy in pp.

For a given particle type of interest, can you claim a “precision measurement” if you indeed miss $x\%$ of production ?
 → yes or no ? to be decided, case by case, but...

NB : ALICE arXiv:1504.0024 = $h^\pm > 0.15 \text{ GeV}/c // \pi^\pm > 0.1 \text{ GeV}/c / K^\pm > 0.2 \text{ GeV}/c, p > 0.3 \text{ GeV}/c...$

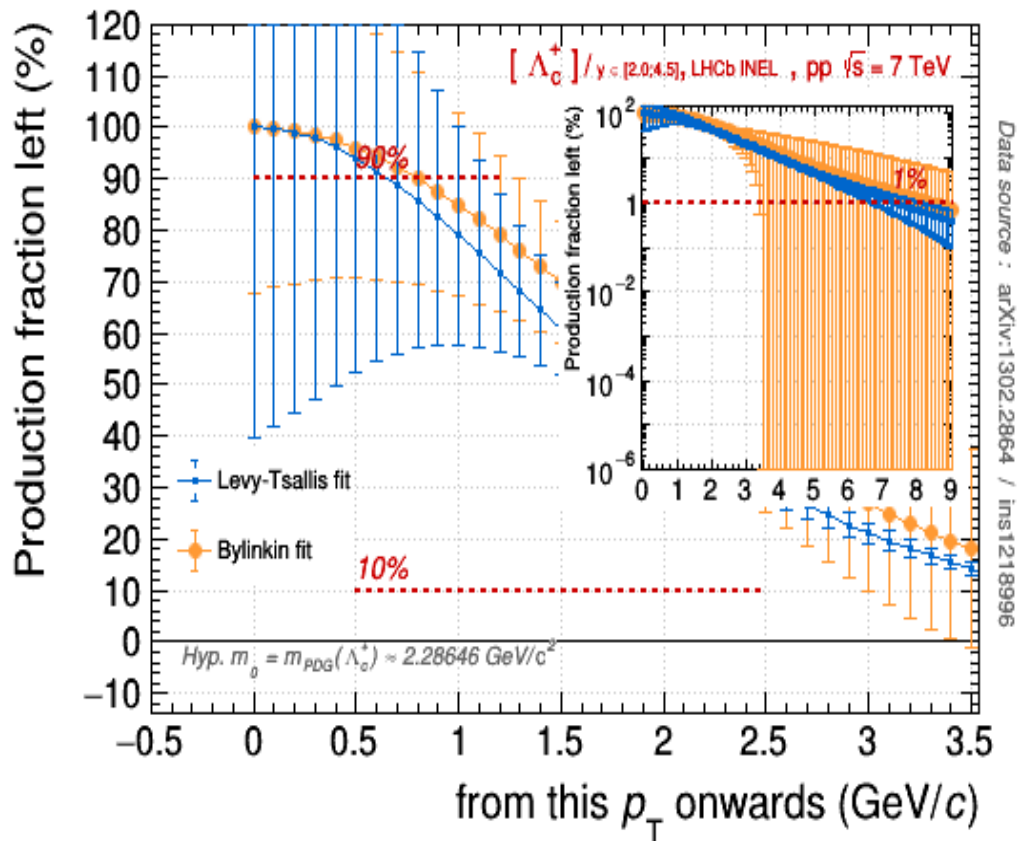
IV.4 – ITS n : why low p_T ? Example Ξ^\pm



If your Ξ (dss) measurement starts
 above 0.0 GeV/c, you miss 0%
 above 0.6 GeV/c, you miss $\approx 23\%$
 above 1.2 GeV/c, you miss $\approx 45\%$
 ... of the total dN/dy in pp

NB :
 ALICE [arXiv:1204.0282](https://arxiv.org/abs/1204.0282), pp 7 TeV $|y| < 0.5, \Xi > 0.6$
 GeV/c

IV.5 – ITS n : why low p_T ? Example of Λ_c^+

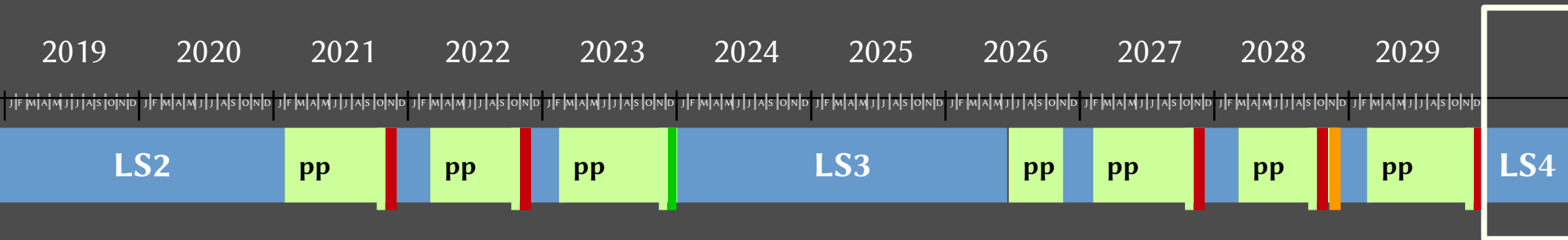


If your $\Lambda_c^+(udc)$ measurement starts above 0.0 / 1.0 / 2.0 GeV/c, you miss x% of the total dN/dy in pp

NB :

LHCb pp [arXiv:1302.2864](https://arxiv.org/abs/1302.2864), $\Lambda_c^+ > 0.0 \text{ GeV}/c$
 ALICE pp [arXiv:1712.09581](https://arxiv.org/abs/1712.09581), $\Lambda_c^+ > 1.0 \text{ GeV}/c$

Part E – All-Si = after LS4 (≥ 2031 , Run 5)



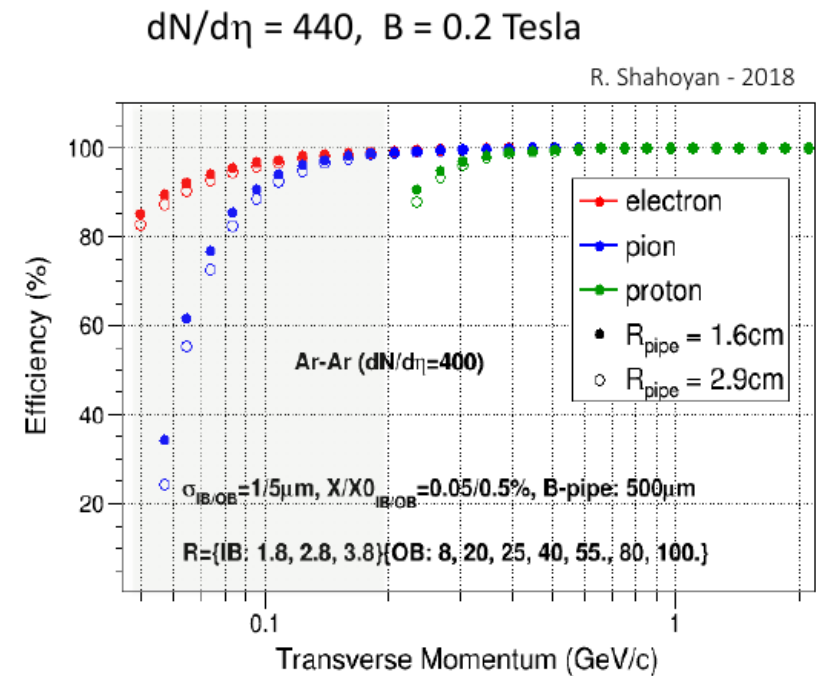
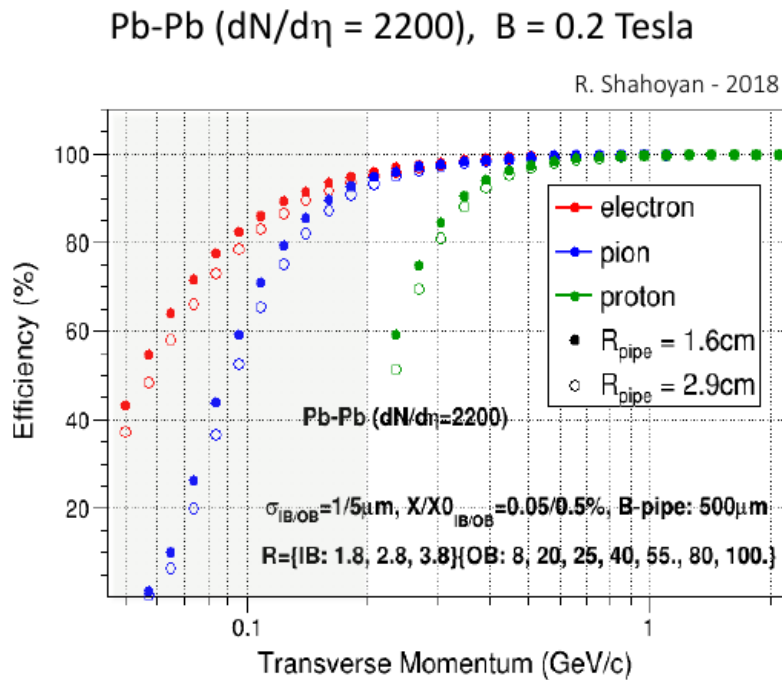
B.1 – ANGHIE : In2p3 perspectives, GT03 contribution

	ITS-2 [3]	ITS-3 [6]	ANGHIE [8]
Période LHC	Run III + IV (2021-29)	Run IV (2026-29)	≥ Run V (>2030)
Nombres de couches	3+4	3 (+4 ITS-2)	O(3+7)
R_{tube}	1,82 cm	1,6 cm	1,6 ou 2,9 ²
$r_{L0} / r_{L1} / r_{L2} \dots r_{\text{Last}}$ (cm)	2,3 / 3,2 / 3,9 ... 39,3	1,8 / 2,4 / 3,0 ... 39,3	1,8 / ... ≈ 100
Champ magnétique $B_{\text{solénoïde}}$	0,2 ou 0,5 T	0,2 ou 0,5 T	0,2 à 1 T
Matière par couche (x/ X_0)	0,3 % à 0,8 %	0,07 % à 0,8 %	0,05 % à 0,5 %
Taille d'un pixel (μm^2)	≈ 30 x 30	≈ 15 x 15 (+ 30 x 30)	≈ 10 x 10 (+ 30 x 30)
Résolution temporelle	≥ 2-5 μs	2-5 μs	≤ 1 μs
Résolution spatiale	5 μm	5 μm	≈ 3-5 μm
Couverture en η	$ \eta < 2,0$ à 1,3	$ \eta < 2,0$ à 1,3	$ \eta < 4,0$
$\varepsilon_{\text{tracking}}(p_T(h^\pm) = X \text{ GeV}/c)$	1 0,1 0,05	1 0,1 0,05	1 0,1 0,05
	98 % 60 % 10 %	98 % 75 % 20 %	98 % 75 % 20 %
Coûts totaux (R&D + Constr.)	≈ 10 MCHF	5,3 MCHF	≈ 80-100 MCHF
Nb d'instituts / Nb de pays	30 / 16	30 / 16	(>399 signataires)👏

B.2 – ANGHIE : tracking efficiencies



Operation at reduced B field for tracking low p_T particles



Efficiency requiring that all particles reach the outermost layer at 1m (10 layers)

⇒ optimization possible (e.g. using only layers up to 40cm)

⇒ improvement for lower $dN/d\eta$

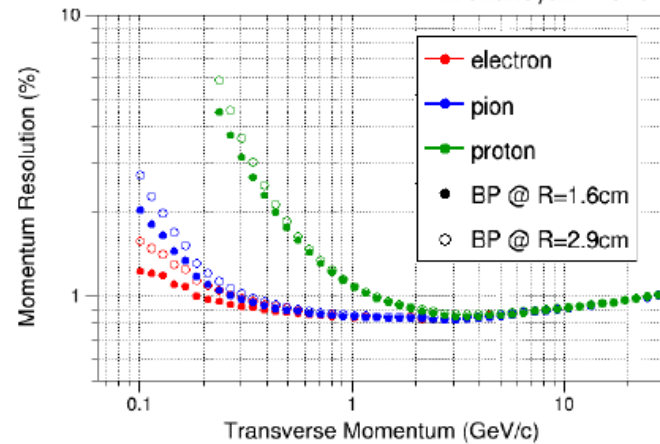
Further layout optimization possible!

B.3 – ANGHIE : momentum resolution

Compared to ALICE in Run3, same performance at high p_T , some improvement at very low p_T

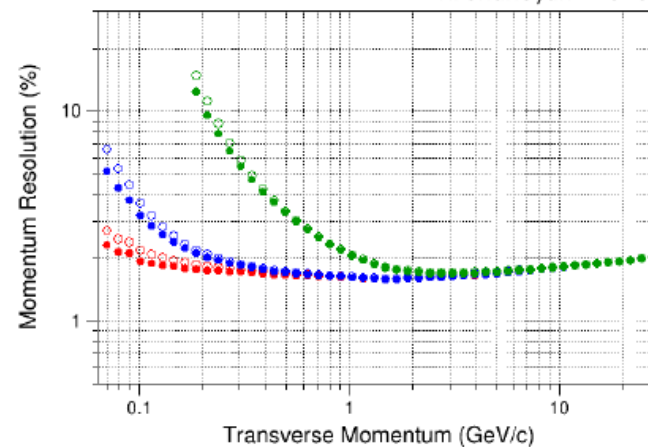
B = 1 T

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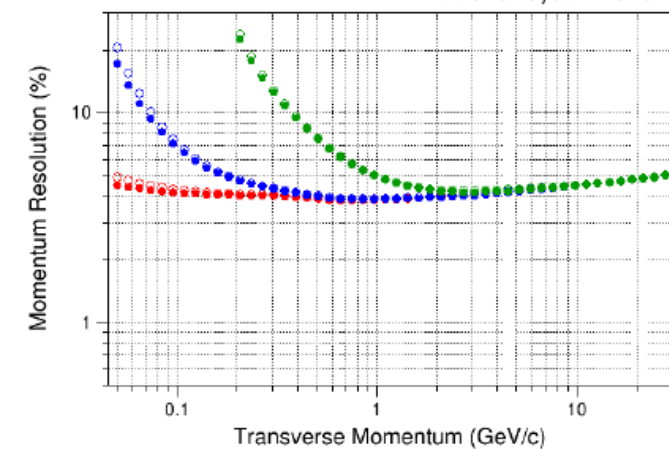
B = 0.5 T

R. Shahoyan - 2018



B = 0.2 T

R. Shahoyan - 2018



momentum resolution for 1GeV/c pions: $\approx 0.8\%$ (1 T), $\approx 1.6\%$ (0.5 T), $\approx 4\%$ (0.2 T)

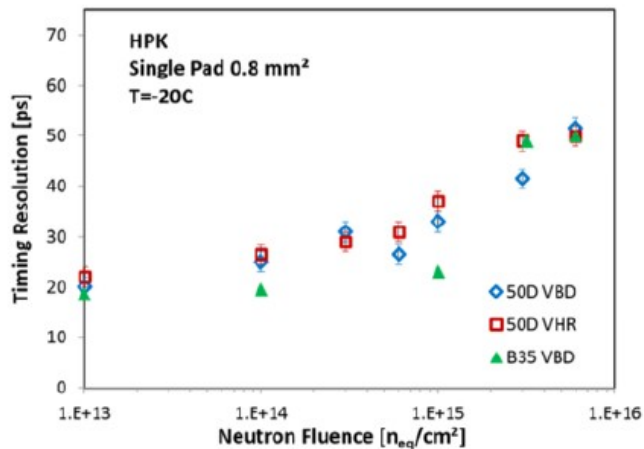
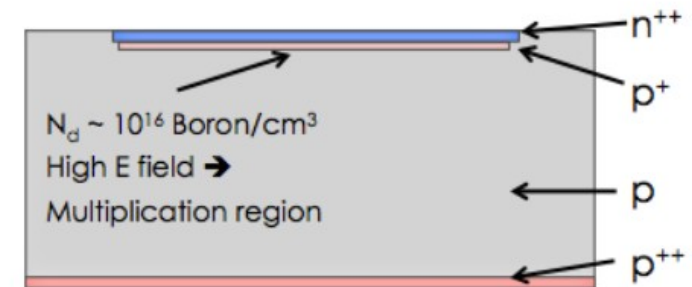
B.4 – ANGHIE : Particle Identification

Electron and hadron ID with TOF



LGAD (Low Gain Avalanche Diode)

- Technology proposed for ATLAS and CMS LS3 upgrades (timing layer)
- Developed for high radiation environment ($10^{14} - 10^{15}$ 1MeV n_{eq}/cm^2)
- Currently low granularity $O(1 \text{ mm}^2)$
- Add a thin layer of doping to produce low controlled multiplication
- Several vendors: Hamamatsu, FBK, CNN



Time resolution vs. neutron fluence of LGAD produced by HPK with a thickness of $50\mu\text{m}$ (50D) and $35\mu\text{m}$ (35D)

Resolution of 20-30ps demonstrated

Cost (CMS estimate) $\sim 50 \text{ CHF}/cm^2$

Can such a gain layer be implemented using CMOS? \Rightarrow large cost saving

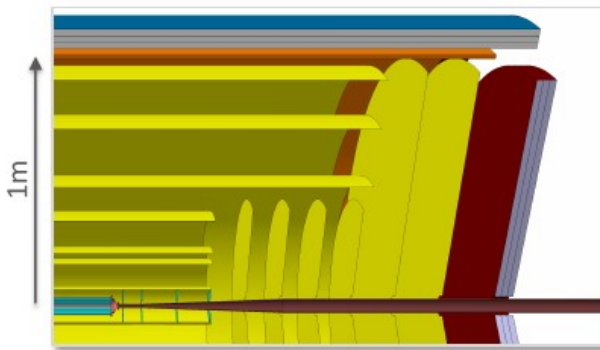
\Rightarrow Single Photon Avalanche Diodes (SPADs)

B.5 – ANGHIE : TOF

Electron and hadron ID with TOF



TOF PID – few barrel layers instrumented with LGAD or high-granularity SPAD sensors



SPAD Sensors (Single Photon Avalanche Diode) ^{def} arrays of avalanche photodiodes reverse-biased above their breakdown voltage

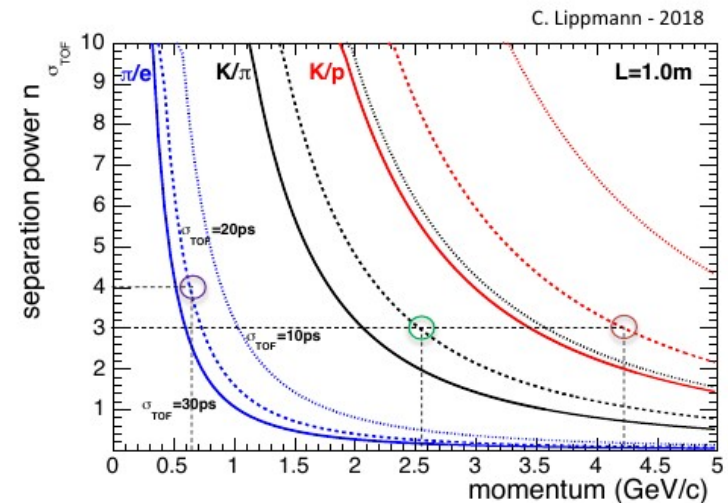
SPAD detectors of recent generation feature a time jitter of tens of picoseconds

Number of layers will depend on time resolution and spatial fill factor achieved in the single layer

Ideal track length and p measurement for 3 scenarios (10ps, 20ps, 30ps) are shown in figure

For $\sigma_{\text{TOF}} = 20\text{ps}$

- e/π (4σ) separation $\lesssim 650\text{ MeV}/c$
- π/K (3σ) separation $\lesssim 2.6\text{ GeV}/c$
- K/p (3σ) separation $\lesssim 4.2\text{ GeV}/c$



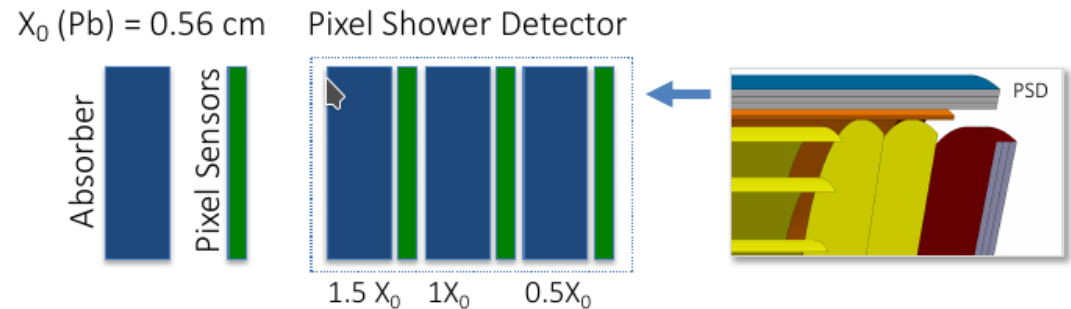
B.6 – ANGHIE : electron pre-shower, PSD...

Electron ID with Pixel Shower Detector



Shower Detector ($3 X_0$) based on high-granularity digital calorimetry (CMOS pixel sensors)

⇒ great potential to identify electrons down to few hundred MeV by detailed **imaging of the initial shower** (particle counting, geometry)



Work in progress – A first look

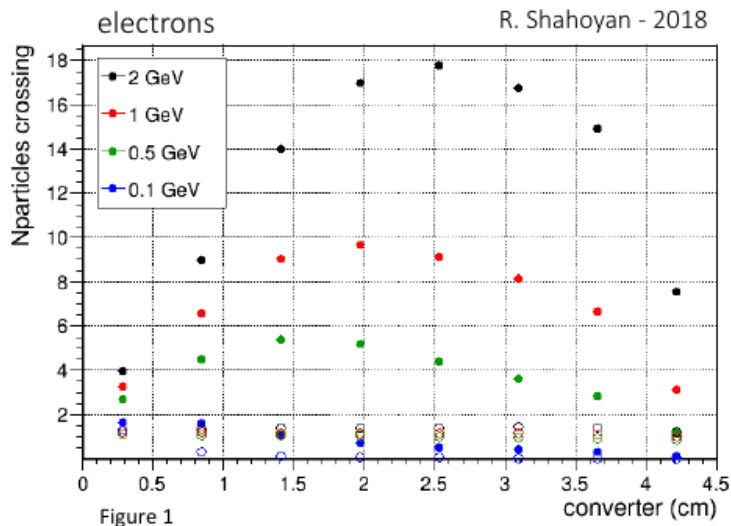


Figure 1

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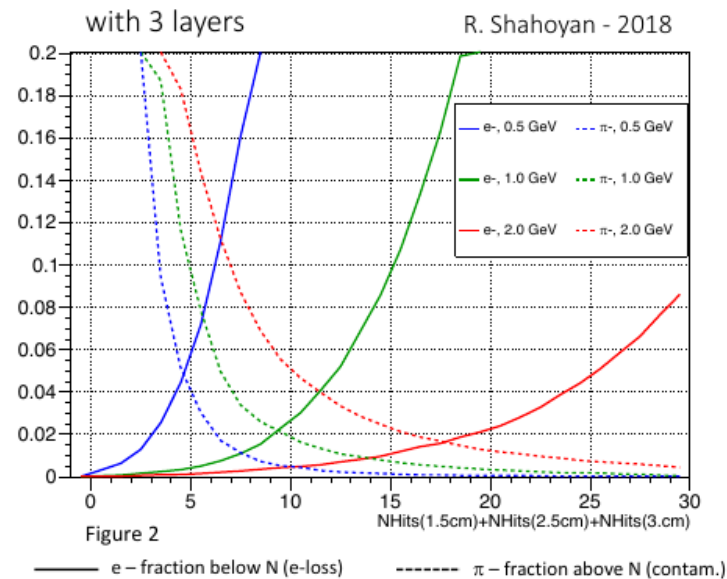


Figure 2

R. Shahoyan - 2018

C.2 – CMS : LHC alternative options possibly on the table

In Run 4+5, after LS3, beware CMS opportunities...

a) tracking on very large η coverage as well ($|\eta| < 4$)

CMS tracker, CERN-LHCC-2017-009

b) unique calorimetry (PbWO₄ EmCal + HGCal SiPM sampling)

CMS HGCal, CERN-LHCC-2017-023

c) MTD = pile-up tagger + TOF ...

CMS MTD = “pile-up tagger”, Fig 1.5 + Fig 5.23 - TDR CERN-LHCC-2019-003

(LGAD in endcap or SiPM in barrel $\rightarrow \sigma_{\text{time stamp}} \approx 30$ ps),

NB: all this, really expensive (quite more than the All-Si exp...),

but ~funded already (112 MCHF tracker, 67 MCHF HGCal, 21 MCHF MTD, DAQ 12 MCHF ...)

→ Could all this be ~bearable (?) for “low- p_T ” purpose ?

(i) in any (?) or at least low pile-up condition (NB : TOF in Pb-Pb = ok !)

(ii) preferentially with moderate B field,

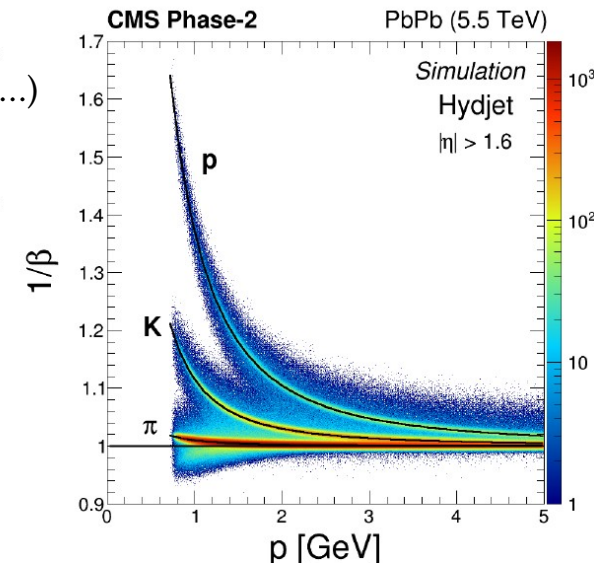
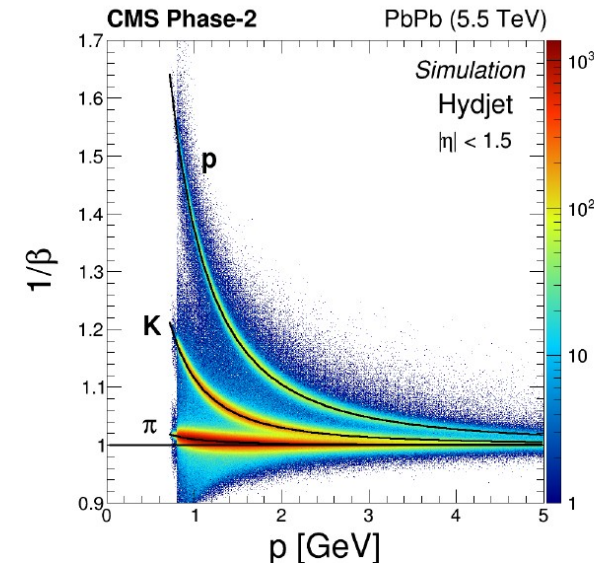
(iii) given material budget in the tracker

(phase-2 \approx 30-40% X/X° as currently at $|\eta| < 1$ + improved at $|\eta| > 1.5$. See Fig 6.2 + 12.1)

→ Decisive but open questions :

- influence of pile-up (pp) / running time negotiated within CMS in (very) low pile-up ?

- running with (B field < 3.8 T) Vs max. number of hysteresis cycles authorised for the CMS magnet ?



C.3 – CMS : MTD aging

Fig B.10 - TDR CERN-LHCC-2019-003

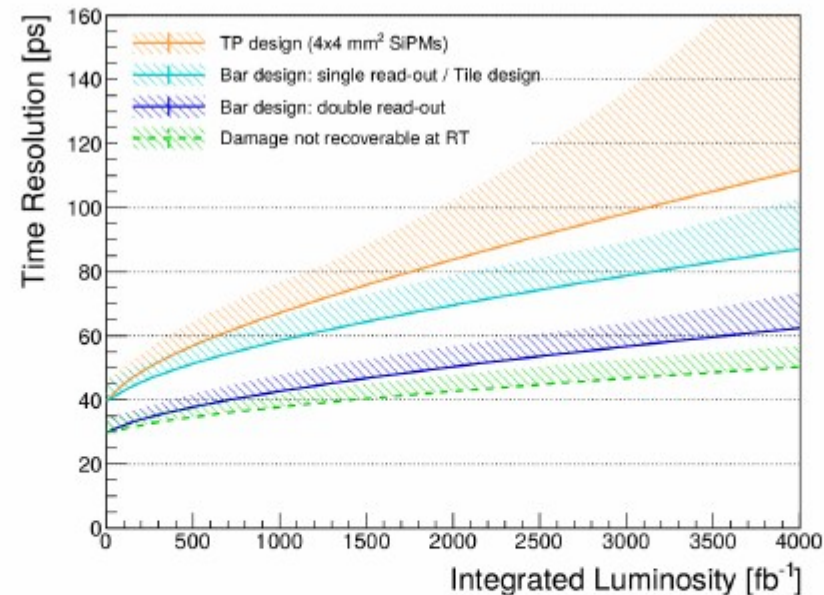


Figure **B.10**: Expected time resolution as a function of integrated luminosity for the TP reference design (orange); the TDR bar design from single-ended and tile design (light blue); the TDR reference design with crystal bars combining double-ended readout (blue); and the TDR reference design assuming all damage recoverable at room temperature (RT) is annealed. The bands show the expected performance for different sets of SiPM parameters.

D.1 – LHCb : LHC alternative options possibly on the table

In Run 5, beware LHCb opportunities...

LHCb, Eol upgrade LS4, arXiv:1808.08865

- a) Profiting from boost for forward geometry,
→ LHCb will remain a serial heavy-flavour tagger...
Sitting forward makes life easier than at mid-rapidity in that respect
- b) Readout/tracking/PID capabilities likely to work by then
in all systems (pp, p-O, Ar-Ar, Xe-Xe, ...)
and under any event activity (Pb-Pb 0-5%)...